

# *USB 3.1 Cable-Connector Assembly Compliance Tests*

## *Test Solution Overview Using the Keysight E5071C ENA Option TDR*

Last Update 2015/02/06

# Purpose

- This slide will show how to make measurements of USB 3.1 cable & connector assemblies compliance tests by using the Keysight E5071C ENA Option TDR.

# Keysight Digital Standards Program

Our solutions are driven and supported by Keysight experts involved in international standards committees:

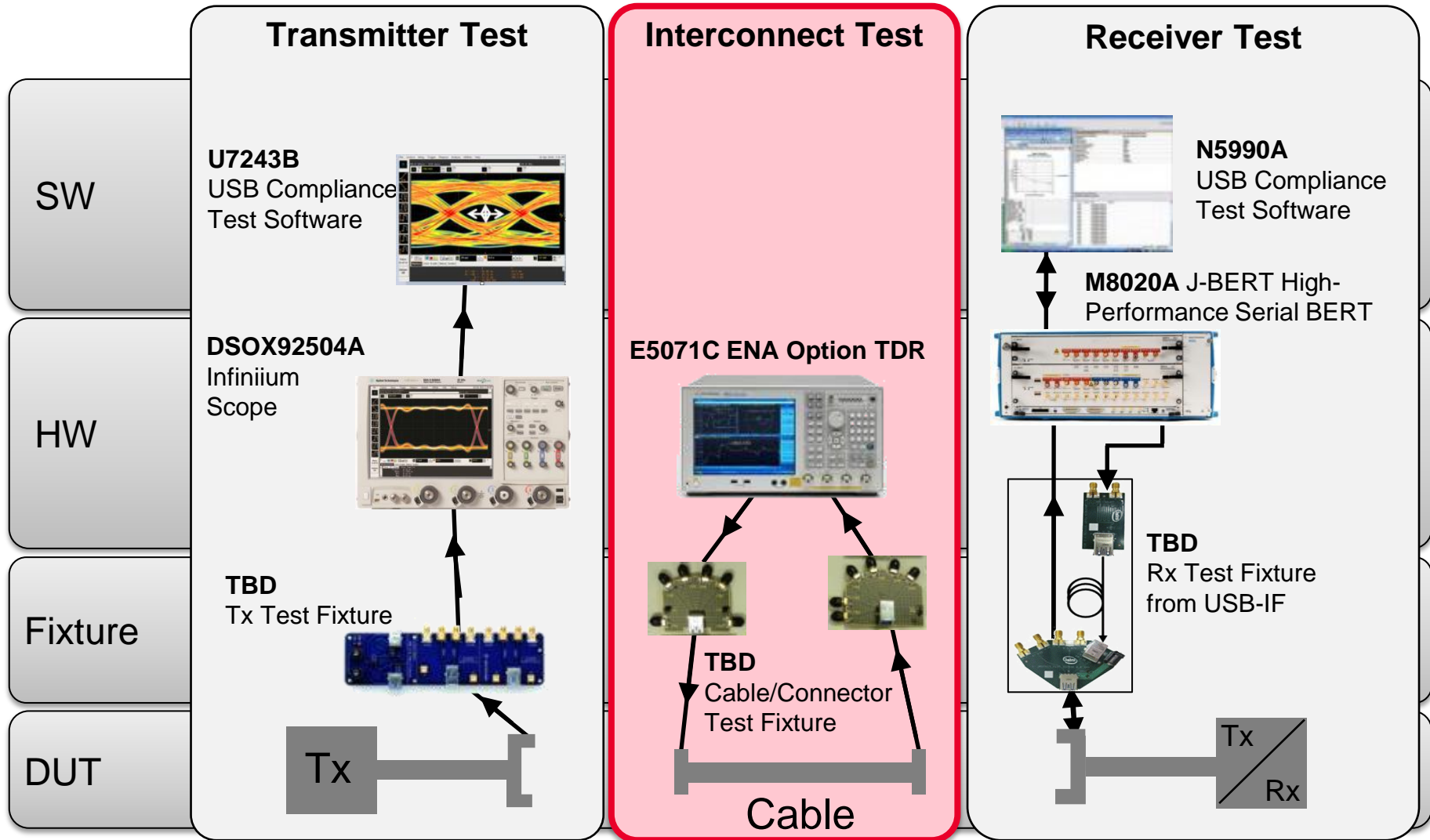
- Joint Electronic Devices Engineering Council (JEDEC)
- PCI Special Interest Group (PCI-SIG®)
- Video Electronics Standards Association (VESA)
- Serial ATA International Organization (SATA-IO)
- [USB-Implementers Forum \(USB-IF\)](#)
- Mobile Industry Processor Interface (MIPI) Alliance
- Optical Internetworking Forum (OIF)

We're active in standards meetings, workshops, plugfests, and seminars

Our customers test with highest confidence and achieve compliance faster

The JEDEC logo consists of the word "JEDEC" in a bold, blue, sans-serif font.The PCI EXPRESS logo features the text "PCI" in a large, black, sans-serif font, followed by a blue stylized arrow pointing right, and the word "EXPRESS" in a smaller, black, sans-serif font below it.The SERIAL ATA logo features the word "SERIAL" in a small, black, sans-serif font above the word "ATA" in a large, blue, sans-serif font, all enclosed within a red and blue border.The DVI logo is a large, black, stylized letter "D" with a vertical bar on the right side.The HDMI logo features the word "HDMI" in a large, bold, black, sans-serif font, with the text "HIGH-DEFINITION MULTIMEDIA INTERFACE" in a smaller, black, sans-serif font below it.The USB logo features the word "USB" in a large, blue, sans-serif font, with a red and white stylized arrow pointing right above it.The MIPI logo features the word "mipi" in a large, black, sans-serif font, with the text "mobile industry processor interface" in a smaller, black, sans-serif font below it.The OIF logo features a blue diamond shape with a white "O" inside, followed by the text "OIF" in a large, blue, sans-serif font, and the text "OPTICAL INTERNETWORKING FORUM" in a smaller, black, sans-serif font below it.

# USB 3.1 – Keysight Total Solution Coverage



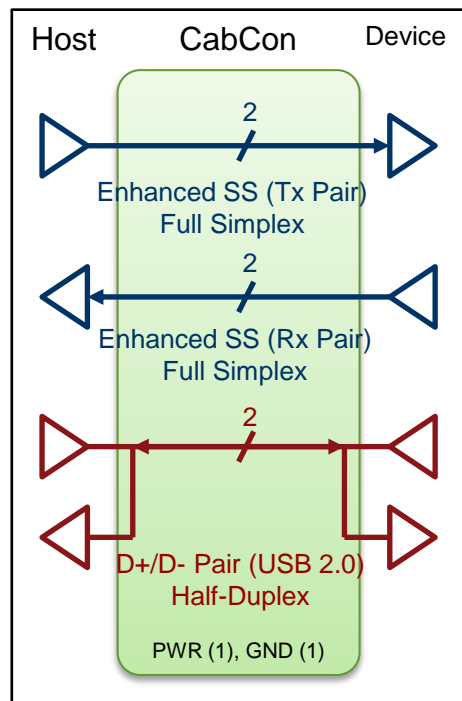
# Reference Document

- Universal Serial Bus 3.1 Specification (Revision 1.0)
- Universal Serial Bus 3.1 Connectors and Cable Assemblies Compliance Document (Draft)

***Note: The final USB 3.1 Connectors and Cable Assemblies Compliance Document (Revision 1.0) is not yet released. Test coverage and requirements are based on an early draft test specification and will be updated when the final test specification is complete.***

# USB 3.1 Cable/Connector Compliance Test

## Cable Assembly

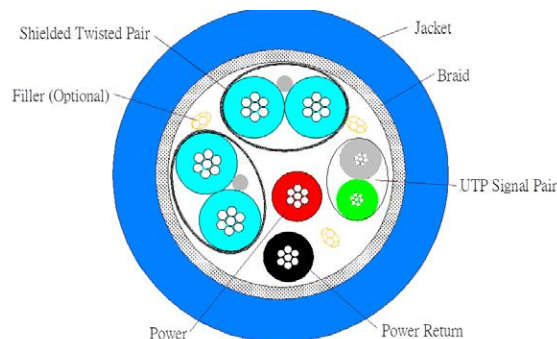


### Enhanced SuperSpeed signal pairs

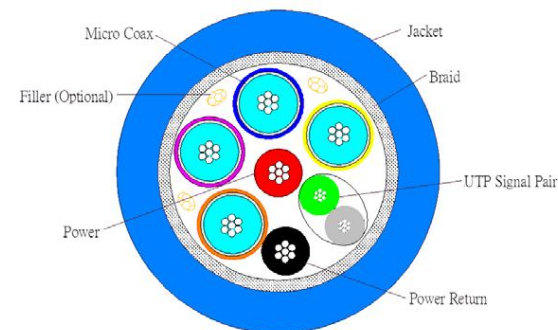
- Typically Shielded Differential Pair (SDP), twisted, or coaxial signal pairs.
- Shield is needed for signal integrity and EMI performance.

### D+/D- signal pair

- Typically unshielded twisted pair (UTP).
- Intended to transmit the USB 2.0 signals.



Shielded twisted pairs

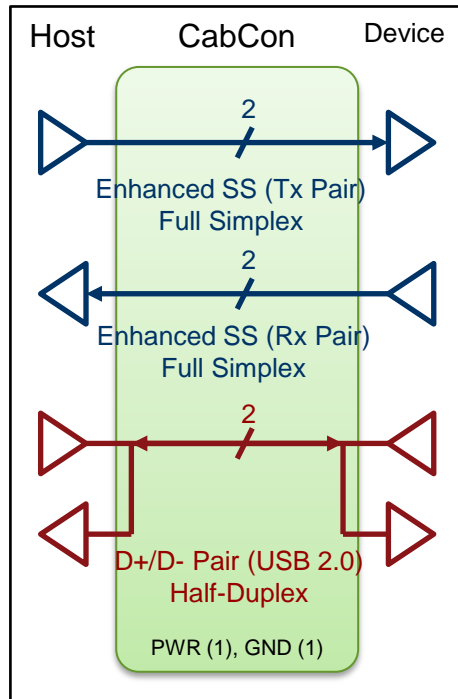


Coaxial signal pairs

# USB 3.1 Cable/Connector Compliance Test

## Measurement Parameters

USB 3.1 connectors and cable assemblies must meet or exceed the requirements specified by the most current version of Chapter 5 of the USB 3.1 Specification and applicable Supplements.



### Time Domain Measurements

- D+/D- Pair Propagation Delay (USB 2.0)
- D+/D- Pair Propagation Delay Skew (USB 2.0)
- Differential Crosstalk between D+/D- and SS+ Signal Pairs
- [Raw Cable] Characteristic Impedance (Informative)
- [Raw Cable] Intra-Pair Skew (Informative)
- [Mated Connector] Impedance (Informative)

### Frequency Domain Measurements

- D+/D- Pair Attenuation (USB 2.0)
- Channel Metrics (eH, eW, ILfitatNq, IMR and IXT)
- Differential to Common-Mode Conversion
- Cable Shielding Effectiveness
- [Raw Cable] Differential Insertion Loss (Informative)
- [Mated Cable Assembly] Differential Insertion Loss (Informative)
- [Mated Cable Assembly] Differential NEXT between SS+ Signal Pairs (Informative)
- [Mated Cable Assembly] Differential NEXT and FEXT between D+/D- pair and SS+ Signal Pairs (Informative)

Note: Normative parameters for the USB 3.1 cable assembly are highlighted in blue

# USB 3.1 Cable/Connector Compliance Test

## Solution Overview

- ALL normative and informative parameters specified for USB 3.1 cable/connector compliance testing can be measured with the ENA Option TDR.

### Frequency Domain

- D+/D- Pair Attenuation (USB 2.0)
- Channel Metrics (eH, eW, ILfitatNq, IMR and IXT)\*
- Differential to Common-Mode Conversion
- Cable Shielding Effectiveness
- [Raw Cable] Differential Insertion Loss (Informative)
- [Mated Cable Assy] Differential Insertion Loss (Informative)
- [Mated Cable Assy] Differential NEXT between SS+ Signal Pairs (Informative)
- [Mated Cable Assy] Differential NEXT and FEXT between D+/D- pair and SS+ Signal Pairs (Informative)

### Time Domain

- D+/D- Pair Propagation Delay (USB 2.0)
- D+/D- Pair Propagation Delay Skew (USB 2.0)
- Differential Crosstalk between D+/D- and SS+ Signal Pairs
- [Raw Cable] Characteristic Impedance (Informative)
- [Raw Cable] Intra-Pair Skew (Informative)
- [Mated Connector] Impedance (Informative)

### Traditional Solution

Vector Network Analyzer (VNA)

TDR Scope

### New Solution

- **ALL** parameters can be measured with **ENA Option TDR**

One-box Solution !!



\* Note: Compliance standard tool from USB-IF is required for pass/fail judgment of channel metrics tests



# ENA Option TDR Compliance Test Solution

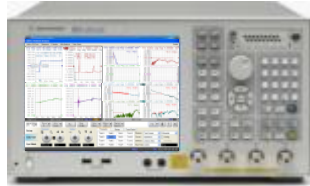
Certified Test Centers using ENA Option TDR

## Test Centers Support ENA Option TDR

ENA Option TDR is used world wide by certified test centers of USB, HDMI, DisplayPort, MHL, Thunderbolt and SATA.



# USB 3.1 Cable/Connector Compliance Test Configuration

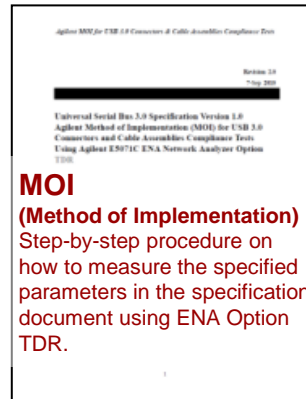


- ENA Mainframe (\*1)
  - E5071C-4K5: 4-port, 300 kHz to 20 GHz
- Enhanced Time Domain Analysis Option (E5071C-TDR)
- ECal Module (N4433A)

\*1: Opt.4K5 (20 GHz) is recommended as Type-C cable/connector requires measurements up to 15 GHz.

\*2: The list above includes the major equipment required. Please contact our sales representative for configuration details.

•Method of Implementation (MOI) document and state file (4K5) available for download on Keysight.com



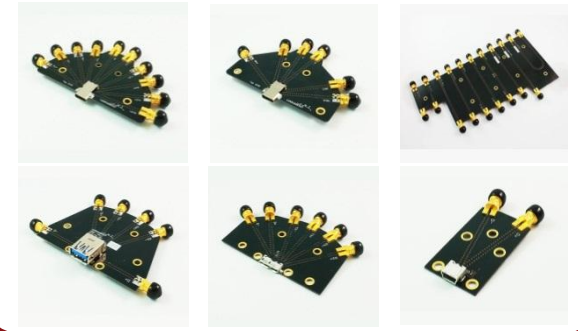
[www.keysight.com/find/ena-tdr\\_compliance](http://www.keysight.com/find/ena-tdr_compliance)  
[www.keysight.com/find/ena-tdr\\_usb3\\_1-cabcon](http://www.keysight.com/find/ena-tdr_usb3_1-cabcon)



## USB 3.1 Test Fixtures

Fixtures for testing USB 3.1/Type-C connectors and cable assemblies are available for purchase through Luxshare-ICT.

<http://web.luxshare-ict.com/en/ProductList.php?id1=22&id2=92>



# USB 3.1 Cable/Connector Compliance Test

## Measurement Parameters (Normative & Informative)

### Time Domain

Tr1 T31 Volt 50.00mV/ Ref 100.  
Tr5 T42 Volt 50.00mV/ Ref 100.

**D+/D-  
Propagation  
Delay Skew  
(T31, T42)**

**D+/D-  
Propagation  
Delay (Tdd21)**

**Diff. Crosstalk  
(D+/D- & SS+)  
(Tdd21)**

**[Raw Cable]  
Intra-Pair  
Skew  
(T31, T42)**

**[Raw Cable]  
Characteristic  
Impedance  
(Tdd11, Tdd22)**

**[Mated Connector]  
Impedance  
(Tdd11, Tdd22)**

### Frequency Domain

**D+/D- Pair  
Attenuation (Sdd21)  
Channel Metrics  
(s4p files)**

**Mode  
Conversion  
(Scd21)**

**Cable Shielding Effectiveness  
(Sds21, Scs21)**

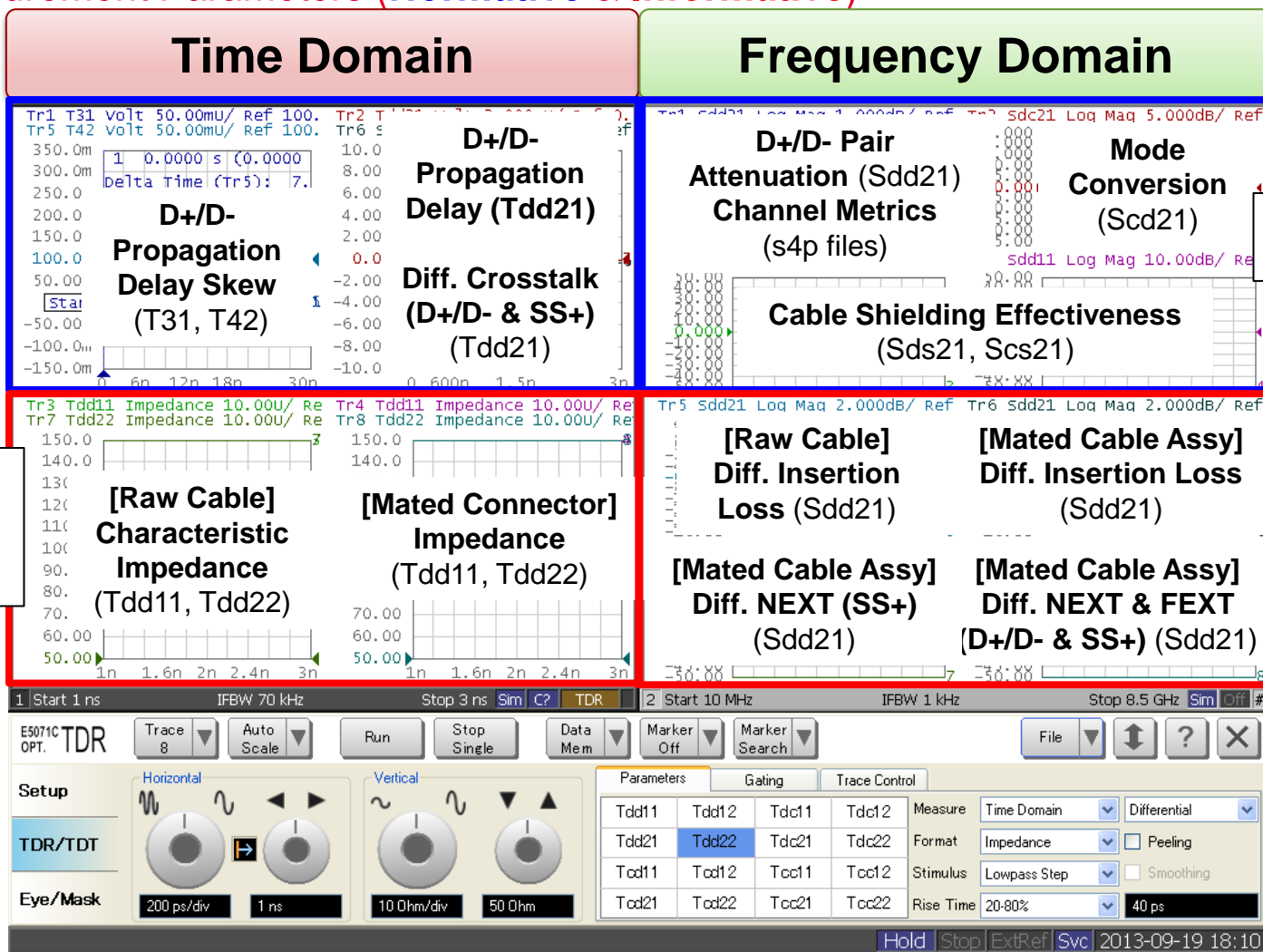
**[Raw Cable]  
Diff. Insertion  
Loss (Sdd21)**

**[Mated Cable Assy]  
Diff. Insertion Loss  
(Sdd21)**

**[Mated Cable Assy]  
Diff. NEXT (SS+)  
(Sdd21)**

**[Mated Cable Assy]  
Diff. NEXT & FEXT  
(D+/D- & SS+) (Sdd21)**

**Compliance  
Tool**



# USB 3.1 Cable/Connector Compliance Test

## Measurement Procedure

Step 1: Setup



- Manual or automatic setup by recalling a state file.
- State files for the ENA Option TDR will be provided for fast setup. Operators' error can be minimized.

Step 2: Calibration



Time-domain Cal

Frequency-domain Cal

ECal + De-embedding or In-fixture TRL Cal

Adjustment of Effective  
Rise Time

- Calibration for frequency-domain measurements shall be performed to remove the unwanted test fixture trace effect.
- ECal + De-embedding or TRL calibration are available with ENA Option TDR.
- Adjustment of effective rise time step is required for time-domain measurements.

Step 3: Measurement

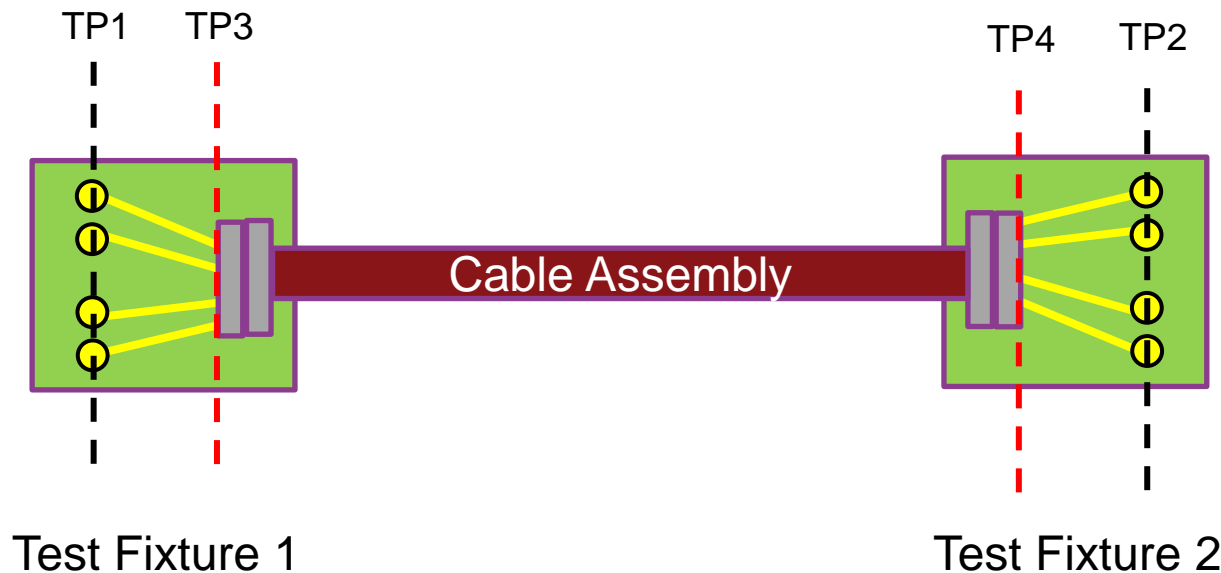


- The ENA Option TDR can be used to perform all measurements.
- Compliance standard tool is required for pass/fail judgment of channel metrics tests.

# USB 3.1 Cable/Connector Compliance Test

## Calibration

- Calibration shall be performed to remove the unwanted test fixture trace effect.
- The procedures of 2x Thru de-embedding and In-fixture TRL calibration are the official procedure introduced in the USB 3.1 Compliance Specification.

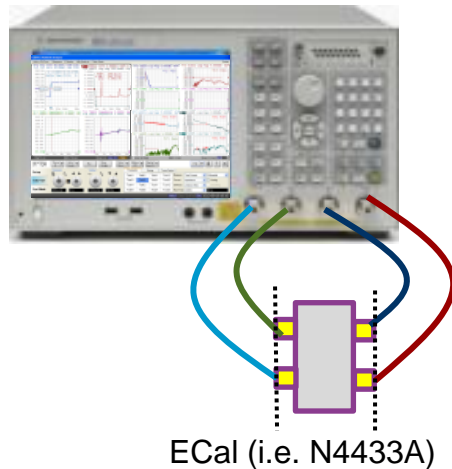


# USB 3.1 Cable/Connector Compliance Test

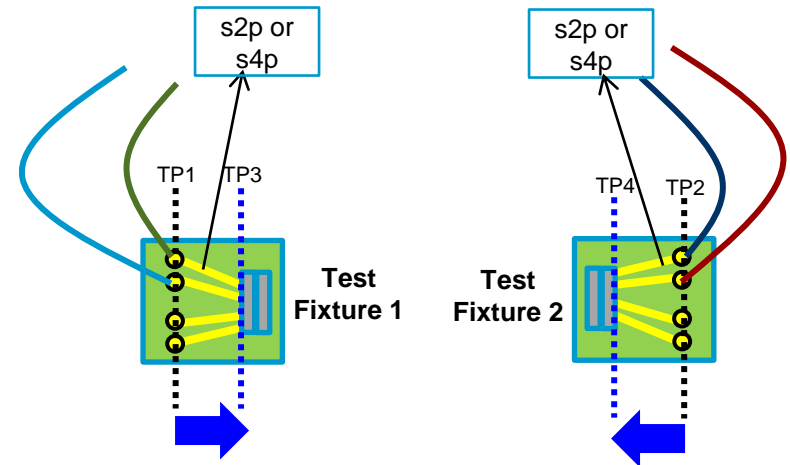
## Calibration

### 1. ECal + De-embedding

#### 1. Full calibration with ECal



#### 2. De-embedding S-parameters of fixture traces



- Full 4-port calibration is performed using the 4-port ECal module (i.e. N4433A).
- The reference plane is established at the end of RF cables connected to the ENA's test ports.

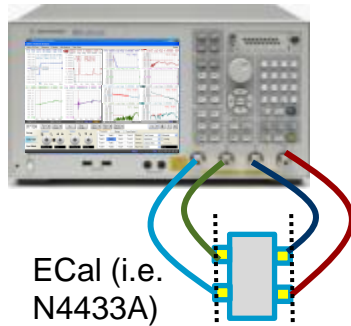
- S-parameter Touchstone files (\*.s2p or .s4p) of fixture traces are excluded from total performance in frequency-domain by using the de-embedding function of the ENA.
- The reference plane is moved to the edge of USB connectors on the test fixtures (TP1->TP3 & TP2->TP4).

# USB 3.1 Cable/Connector Compliance Test

## Calibration

Creating de-embedding files with PLTS

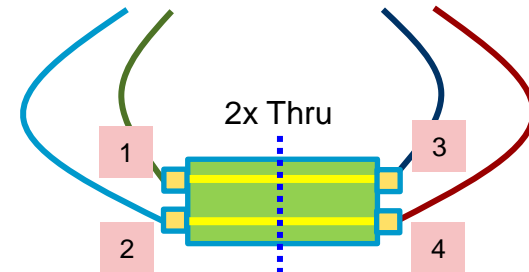
### 1. Full calibration with ECal



- Perform full 4-port calibration using the ECal module (i.e. N4433A).

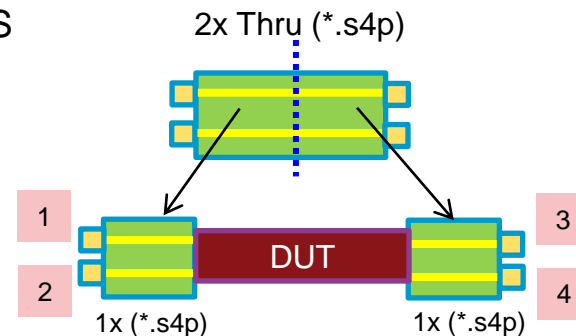
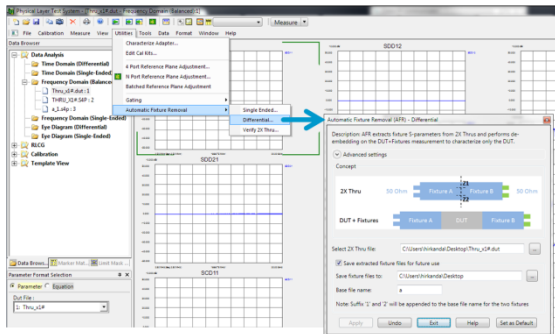


### 2. Measure 2x Thru standards



- Perform 4-port measurement and save 4-port S-parameter file (\*.s4p).

### 3. Create de-embedding files by AFR with PLTS



- Launch PLTS software on PC
- Import measured 4-port file (\*.s4p)
- Create two de-embedding files (\*.s4p)
- Change port configuration (optional)

# USB 3.1 Cable/Connector Compliance Test

## Calibration

### 2. TRL Calibration



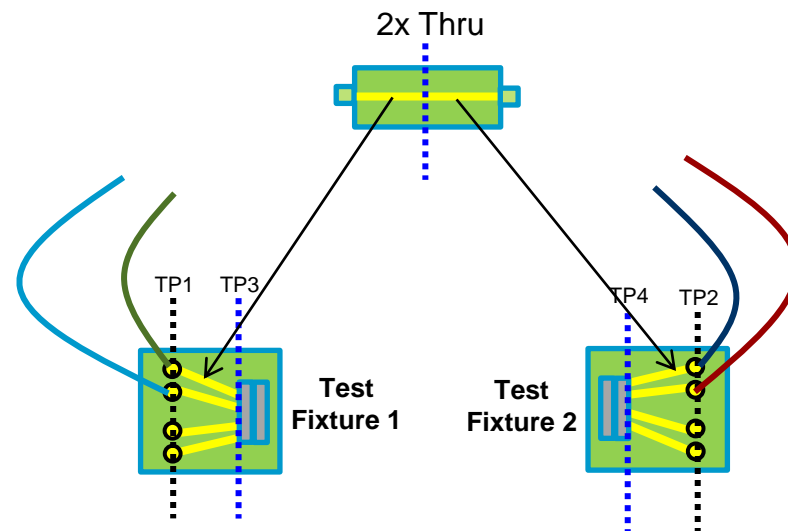
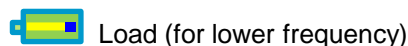
Thru



Reflection



Line



•TRL (Thru, Reflection, Line) calibration is performed by using the USB 3.1 official TRL calibration standards for three combinations between the ENA's test ports (Port 1&2, Port 1&3, Port 3&4).

•The electrical length of 2x Thru is equal to the length of the trace between TP1 and TP3 plus the length of the trace between TP2 and TP4.  
•Reference plane is set at the edge of USB connectors on the test fixtures (TP3 & TP4).



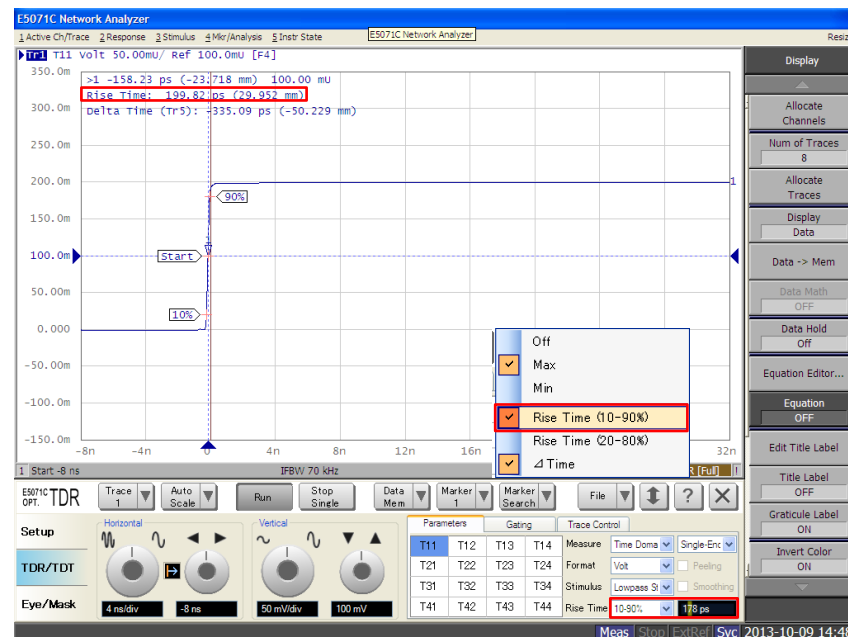
# USB 3.1 Cable/Connector Compliance Test

## Calibration (Adjustment of Effective Rise Time in Time Domain)

Test Items	Rise Time (%)	Target Rise Time
D+/D- Pair Propagation Delay and Skew	10 – 90 %	200 ps
Differential Crosstalk between D+/D- and SS+ Signal Pairs	10 – 90 %	500 ps
[Raw Cable] Characteristic Impedance	10 – 90 %	200 ps
[Mated Connector] Impedance	20 – 80 %	40 ps

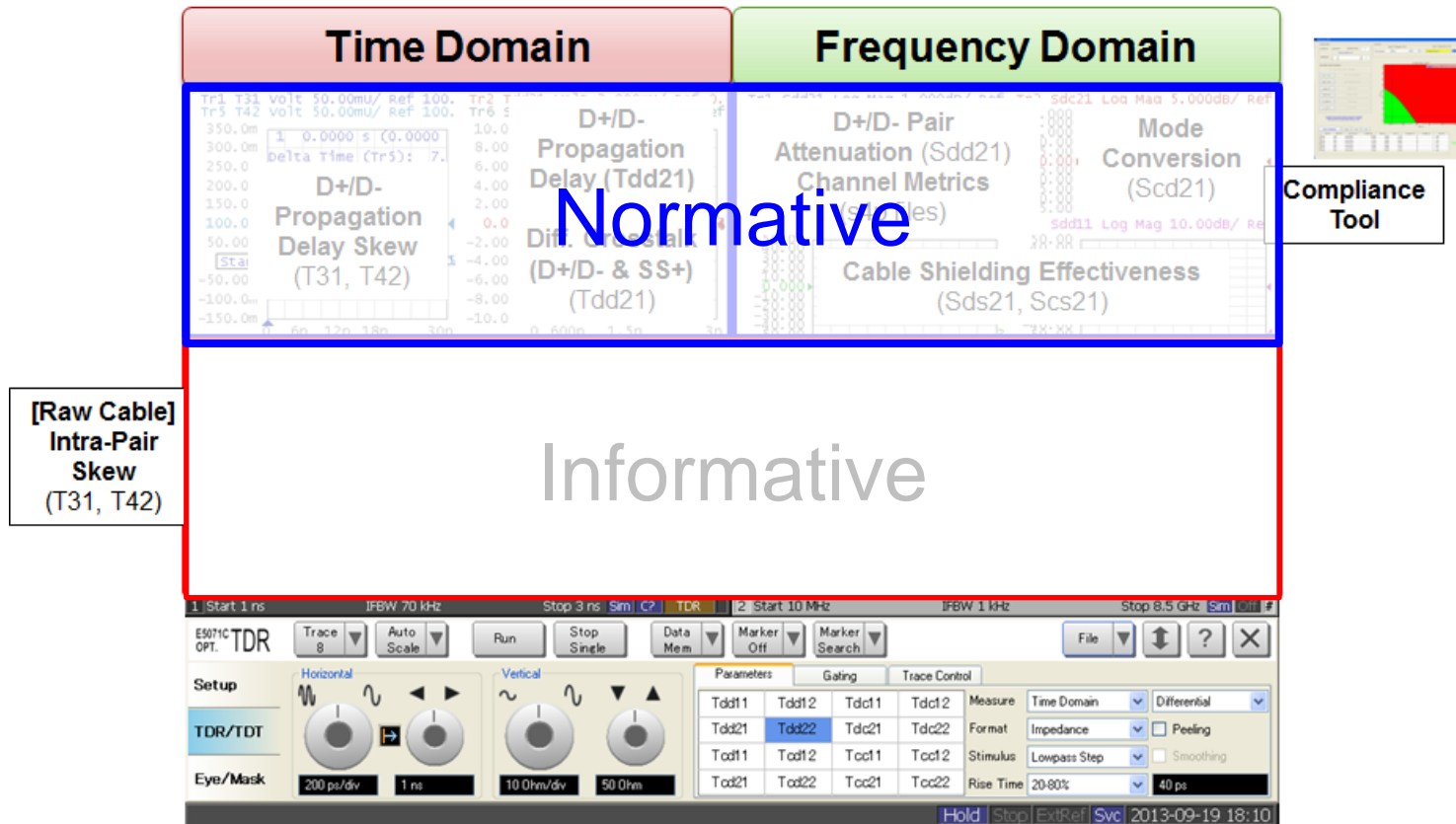
- The effective rise time entering the USB 3.1 connector pins is adjusted for the specification in time-domain measurements.
- 1x Thru standard is connected to the E5071C port with RF cables. DUT is disconnected during the adjustment procedure.

- The effective rise time for test items is specified as shown in the table.



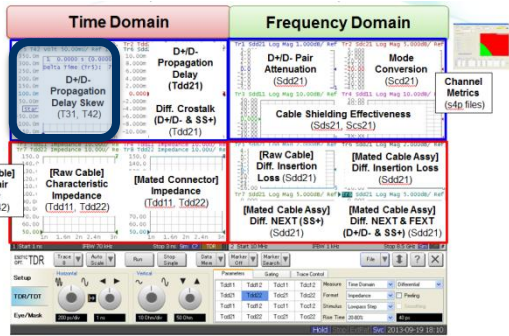
# USB 3.1 Cable/Connector Compliance Test

## Normative Parameters

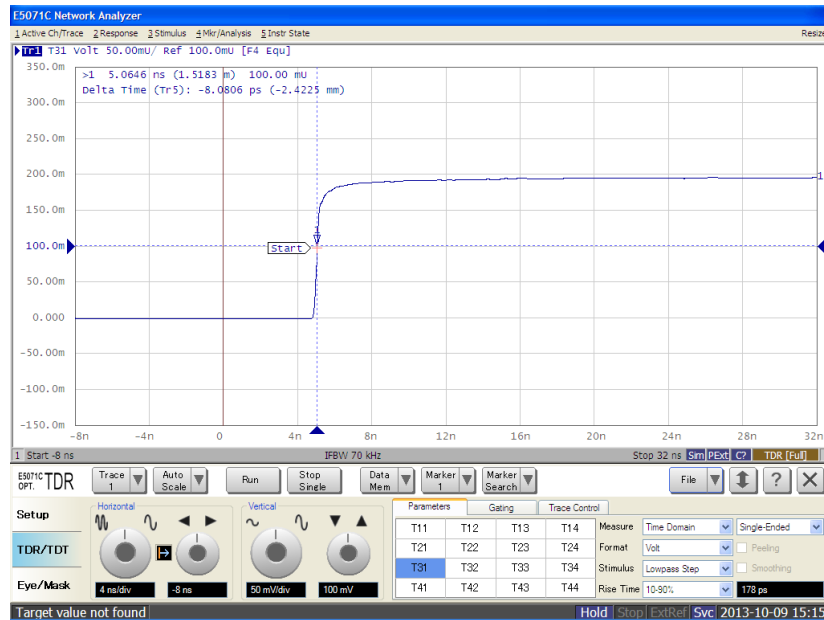
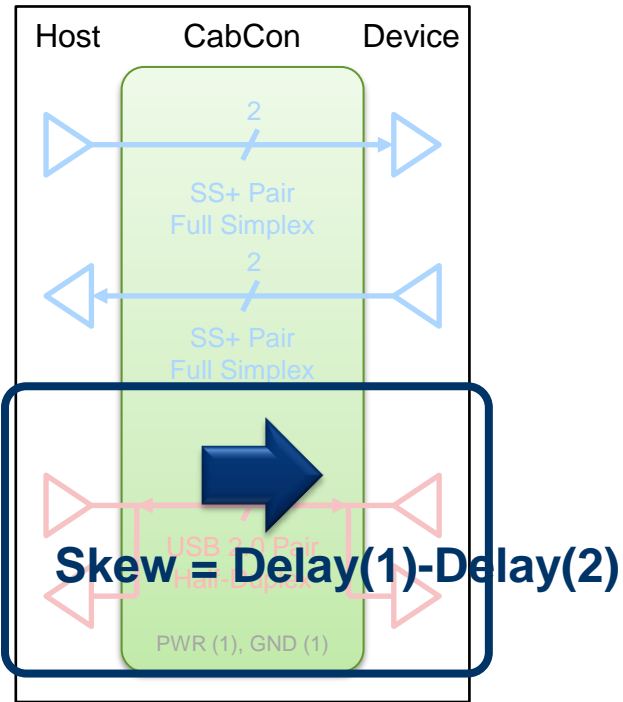


# USB 3.1 Cable/Connector Compliance Test

## D+/D- Pair Propagation Delay Skew (Normative)



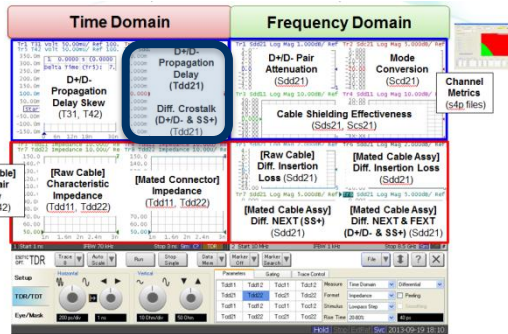
- Intra-pair skew measurement ensures the signal on both the D+ and D- lines of a cable assembly arrive at the receiver at the same time.
- If Delta Time < 100 psec, Pass. Else, Fail.



Note: Should be measured with a TDR in a differential mode using a 200 ps (10%-90%) rise.

# USB 3.1 Cable/Connector Compliance Test

## D+/D- Pair Propagation Delay (Normative)

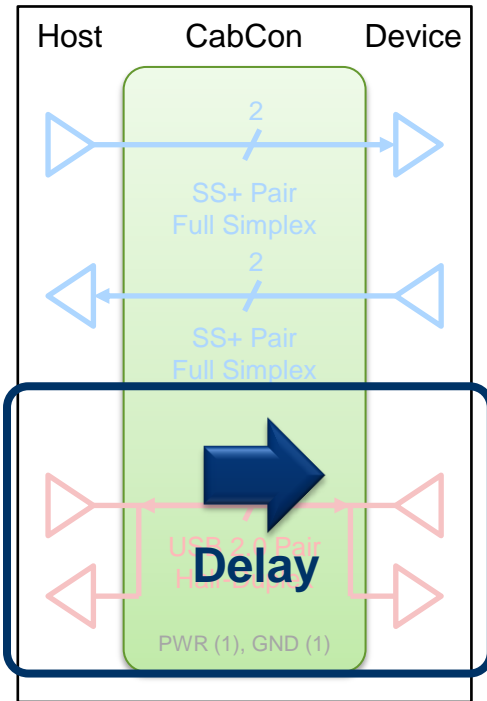


- Propagation delay measurement verifies the end-to-end propagation of the D+/D- lines of the cable assembly.

## D+/D- Pair Propagation Delay - Specification

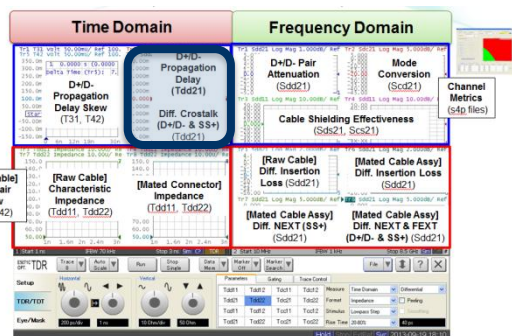
DUT Type	Limit
Standard-A to Standard-B Standard-A to Standard-A	If the time at the rising edge is < 26 nsec, Pass. Else Fail.
Standard-A to Micro-AB Micro-AB to Micro-AB Micro-AB to Standard-B	If the time at the rising edge is < 10 nsec, Pass. Else Fail.

Note: Should be measured with a TDR in a differential mode using a 200 ps (10%-90%) rise time.

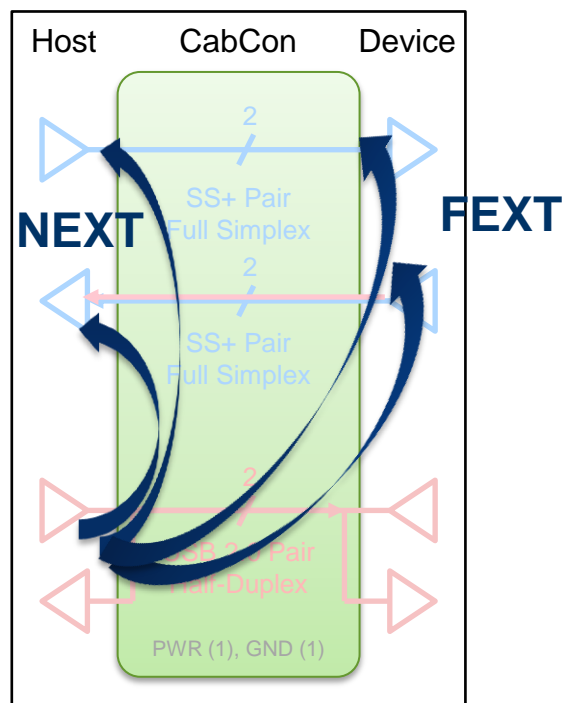
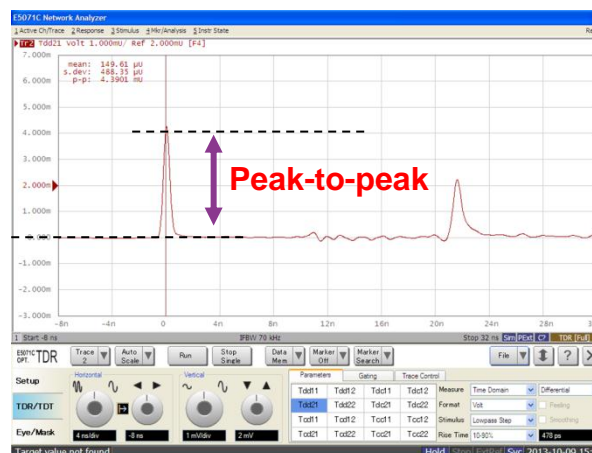


# USB 3.1 Cable/Connector Compliance Test Solution

## Differential Crosstalk between D+/D- and SS+ Signal Pairs (Normative)



- Measure of coupling between D+/D- pair and the SS+ differential pairs (Tx/Rx pair).
- Differential near-end crosstalk and far-end crosstalk shall be measured **in time domain**.



### Crosstalk between D+/D- Pair and SS+ Pairs - Specification

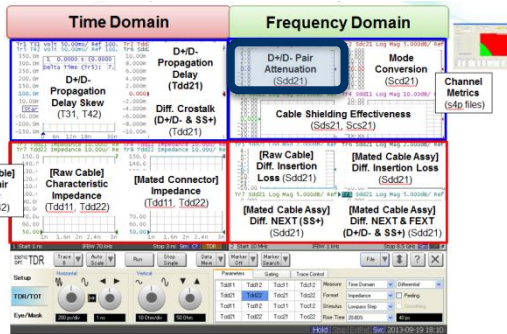
DUT Type	Limit
USB 3.1 Standard-A Connector	2%
USB 3.1 Standard-B Connector	
USB 3.1 Micro Connector Family	

Note: Shall be measured with a rise time of 500 ps (10%-90%) entering the connector under test.

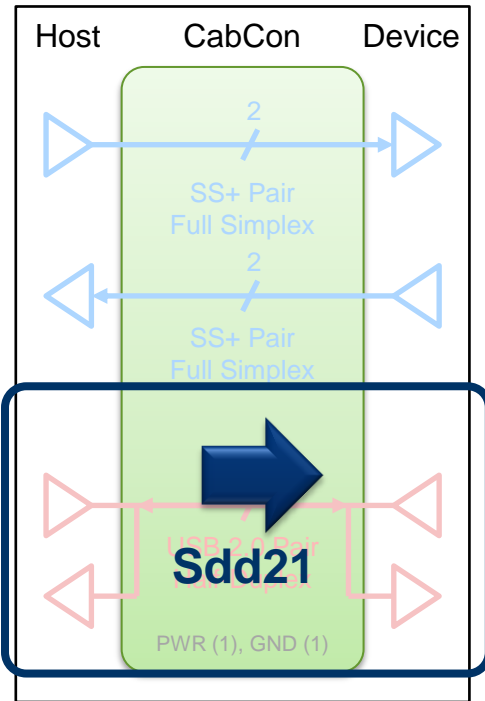
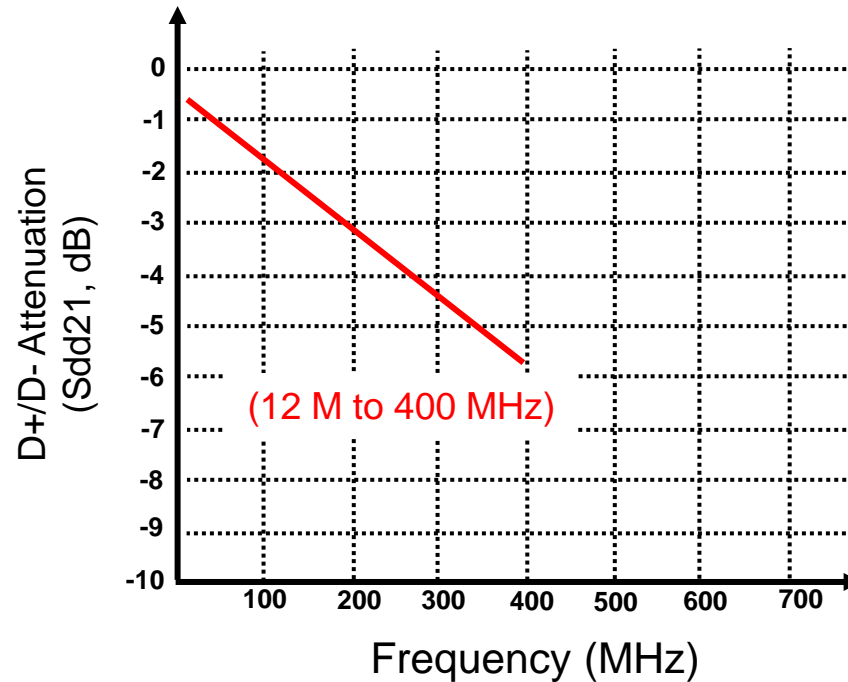
# USB 3.1 Cable/Connector Compliance Test

## D+/D- Pair Attenuation (Normative)

- Ensures the D+/D- pair of a cable assembly can provide adequate signal strength to the receiver to maintain a low error rate.



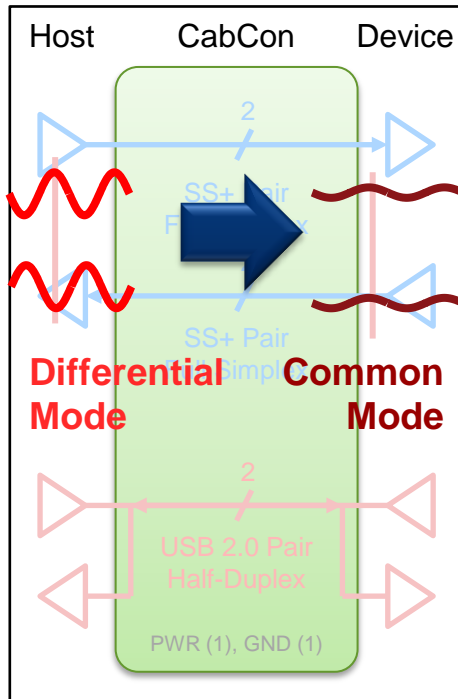
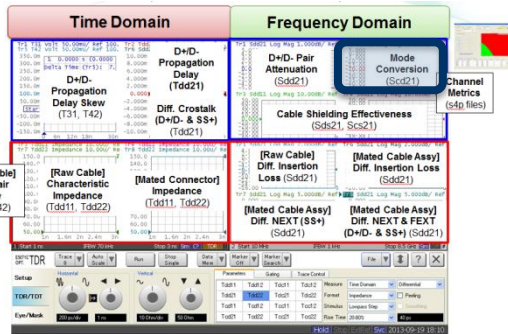
D+/D- Pair Attenuation - Specification



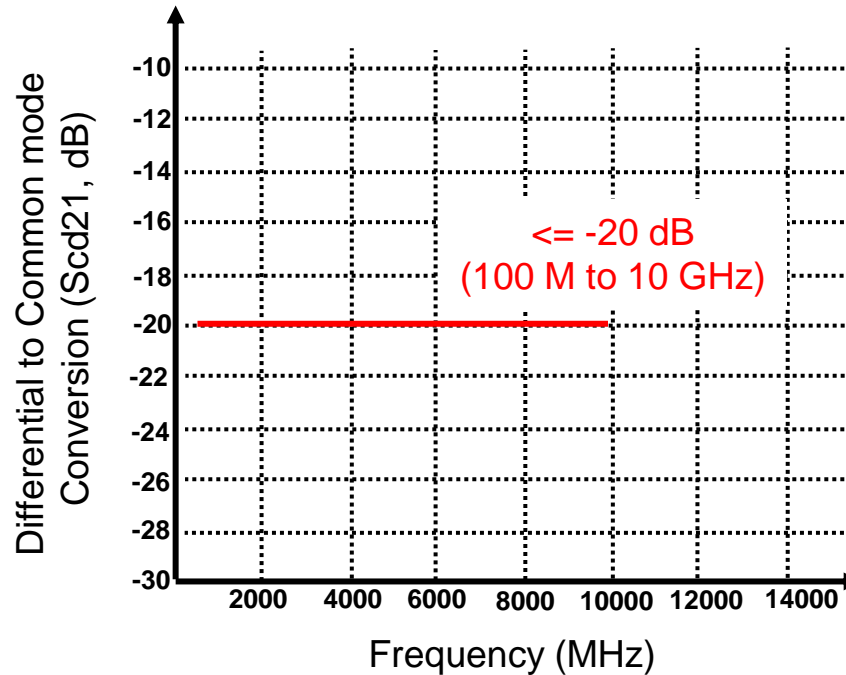
# USB 3.1 Cable/Connector Compliance Test

## Differential to Common-Mode Conversion (**Normative**)

- Common-mode current is directly responsible for EMI and Scd21 is a measure of EMI generation.
- Main purpose of this requirement is to limit EMI emission.



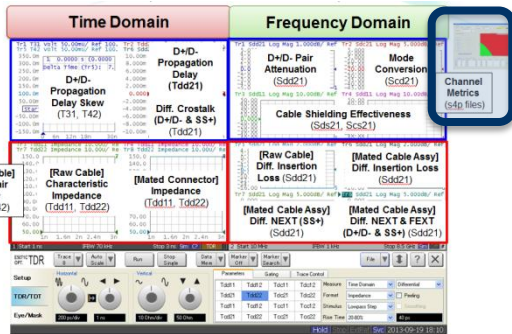
### Differential to Common-Mode conversion - Specification



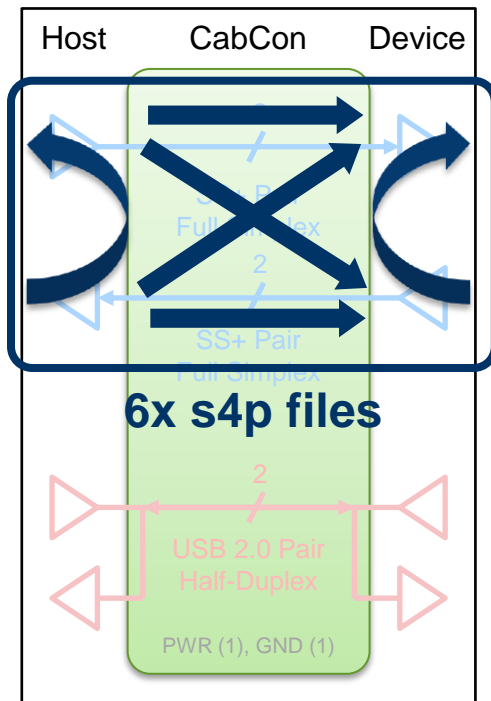


# USB 3.1 Cable/Connector Compliance Test

Channel Metrics (eH, eW, ILfitatNq, IMR and IXT) (**Normative**)



- Three parameters of channel metrics (ILfitatNq, IMR and IXT) and channel margin (eW, eH) are calculated for SS+ pairs.
- USB 3.1 standard tool provided by USB-IF will do the pass/fail judgment for channel metrics and channel performance based on measured Touchstone files. (6x s4p or 1x s8p file)



## Channel Metrics and Channel Performance - Specification

Time domain response:

$$eH = f_H(ILfitatNq, IMR, IXT) > 0$$

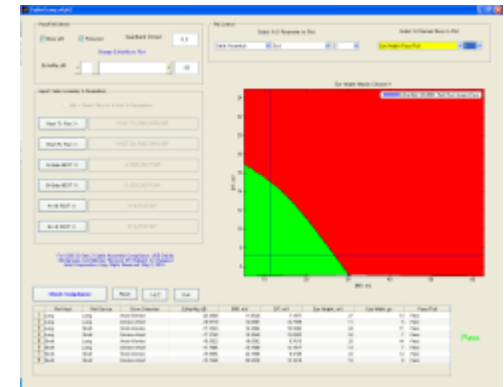
$$eW = f_W(ILfitatNq, IMR, IXT) > 0$$

Frequency response:

$$ILfitatNq \geq -22 \text{ dB}$$

$$IMR \leq 60 \text{ mV}$$

$$IXT \leq 25 \text{ mV}$$



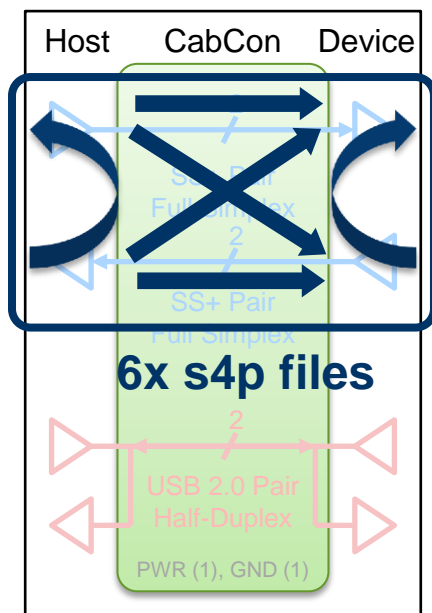
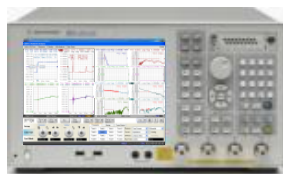


# USB 3.1 Cable/Connector Compliance Test

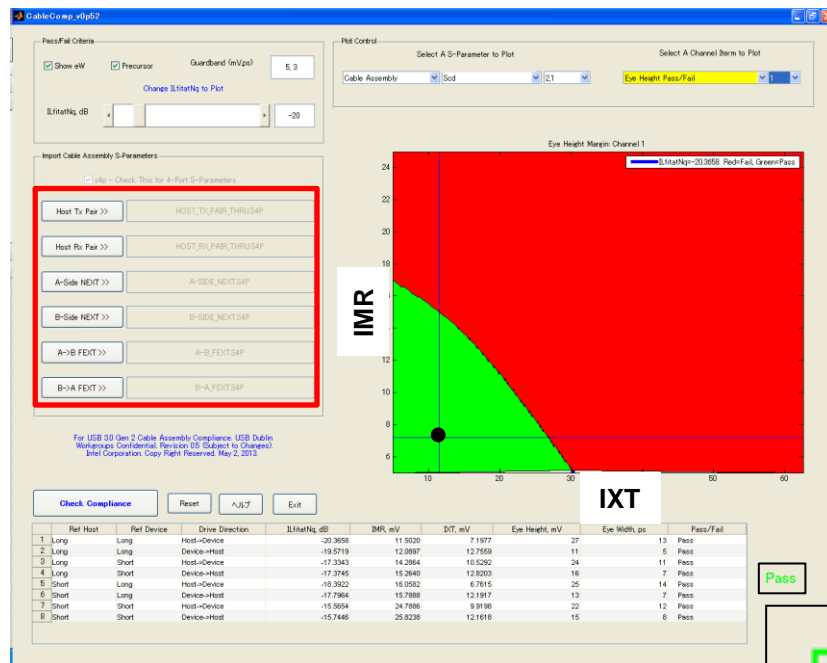
Channel Metrics (eH, eW, ILfitatNq, IMR and IXT) (**Normative**)

ENA Option TDR

USB 3.1 Standard Tool



Perform frequency-domain (S-parameter) measurements to save 6x 4-port Touchstone files (\*.s4p) for SS+ Signal Pairs.



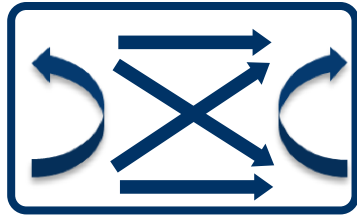
Import 6x Touchstone files (\*.s4p) to do pass/fail judgment for all the combinations of reference host and device.

Pass

Pass

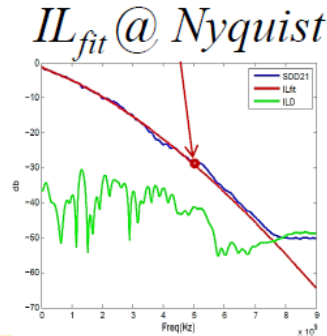
# USB 3.1 Cable/Connector Compliance Test

Channel Metrics (eH, eW, ILfitatNq, IMR and IXT) (**Normative**)



6x s4p files

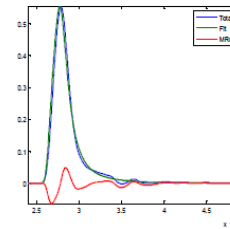
6x 4-port Touchstone S-parameter files (\*.s4p) are saved and imported to the tool.



Differential insertion loss is fitted with a smooth function to obtain the insertion loss at Nyquist frequency of 5 GHz (ILfitatNq).

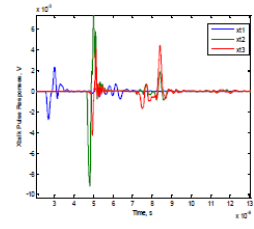


IMR



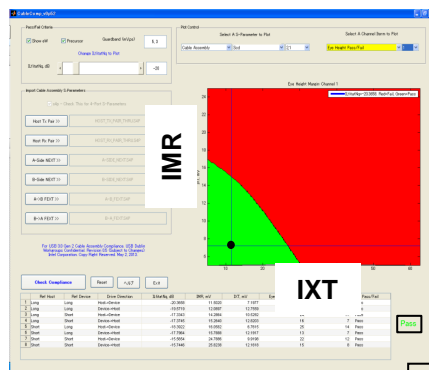
$$IMR = \frac{1}{UI} \sqrt{\int_{-\infty}^{\infty} MR(f)^2 df}$$

IXT



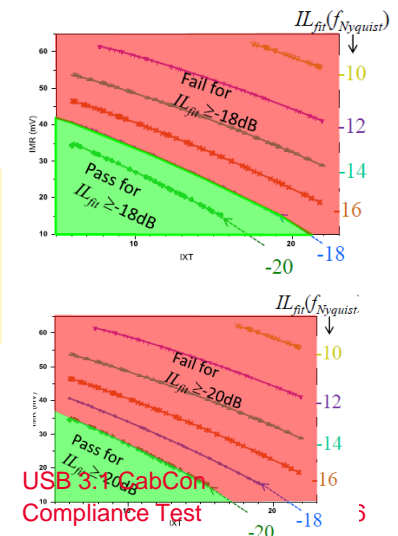
$$IXT = \frac{1}{UI} \sqrt{\int_{-\infty}^{\infty} XT(f)^2 df}$$

Integrated Crosstalk (IXT) and Integrated multi-reflection (IMR) response are calculated from S-parameter files.



The tool illustrates a crossing point of IXT and IMR for a given ILfitatNq. If the point is in the pass region (in green) for all 8 channels, Pass. Otherwise Fail.

Pass



# USB 3.1 Cable/Connector Compliance Test

## Obtaining Multiport Touchstone Files (\*.snp) with Multiport VNA

- USB 3.1 standard tool requires multiport Touchstone file(s) for the pass/fail judgment of cable assemblies with **4x differential (=8x single-ended) ports**.
- To improve throughput of total characterization, the 8-port VNA can create an \*.s8p file with a single measurement.

4-port VNA

		Receiver Port (Diff.)			
		1	2	3	4
Source Port (Diff.)	1			2	3
	2			4	5
	3				6
	4				

Port combinations (# of tests):

1&2, 1&3, 1&4 (3)

2&3, 2&4 (2)

3&4 (1)

**=> 6x 4-port tests (\*.s4p)**

8-port VNA

		Receiver Port (Diff.)			
		1	2	3	4
Source Port (Diff.)	1	1			
	2				
	3				
	4				

Port combinations (# of tests):

1, 2, 3, 4 (1)

**=> 3x 8-port tests (\*.s8p)**

# USB 3.1 Cable/Connector Compliance Test

## Multiport Configuration with M937X PXIe VNA



### Keysight PXI VNA (M937xA)

- Full two-port VNA that fits in just *one* slot.
- Performs fast, accurate measurements and reduces cost-of-test by simultaneously characterizing many devices using a single PXI chassis.

### Performance

- **>114 dB** dynamic range at 9 GHz
- Less than **0.003 dB** of trace noise
- Sweep speed as fast as **16 msec** across 401 points (300 k to 9 GHz, full 2-port correction)
- Stability of 0.005 dB/deg.C

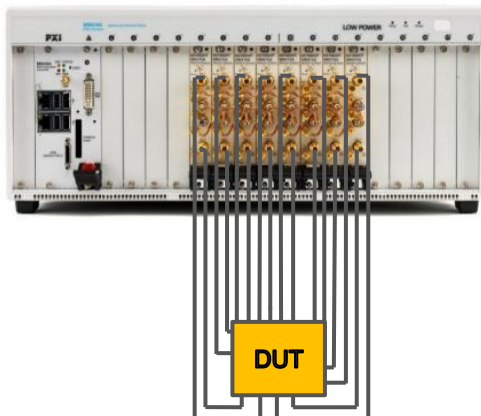
### Key Features

- Six frequency models: 4, 6.5, 9, 14, 20, 26.5 GHz
- Same calibration and measurement science as the trusted FieldFox, ENA and PNA families
- **True multiport VNA with full n-port calibration**
- Simultaneous multi-site measurements with independent VNAs

# USB 3.1 Cable/Connector Compliance Test

## Multiport VNA Configuration

### Recommended Configuration of Multiport VNA



Model / Option	Description	ea
M9373A or M9374A	300 k to 14 GHz or 20 GHz, 2-port, PXIe Vector Network Analyzer	2 (for 4-port VNA) 4 (for 8-port VNA)
M9373A-010 or M9374A-010	Time domain analysis	1 (*1)
M9373A-102 or M9374A-102	Additional VNA features (i.e. differential conversion of fixture simulators)	1 (*1)
M9373A-551 or M9374A-551	Full N-port calibrated measurement	1 (*1)
N4433A	ECal module, 300 k to 20 GHz, 4-port.	1
M9018A	18-slot PXIe chassis	1
M9037A	High-performance embedded controller	1

\*1: At least one PXI VNA module must have option 010, 102, or 551 to enable the capabilities in a multiport configuration.

\*2: The list above includes the major equipment required. Please contact our sales representative for configuration details.

For more details of M937X PXI VNA:

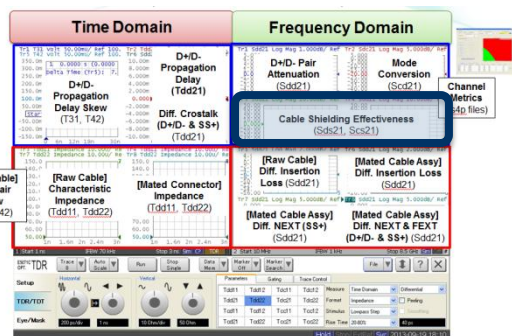
[Product page] [www.keysight.com/find/pxivna](http://www.keysight.com/find/pxivna)

[Configuration Guide] <http://literature.cdn.keysight.com/litweb/pdf/5991-4885EN.pdf>

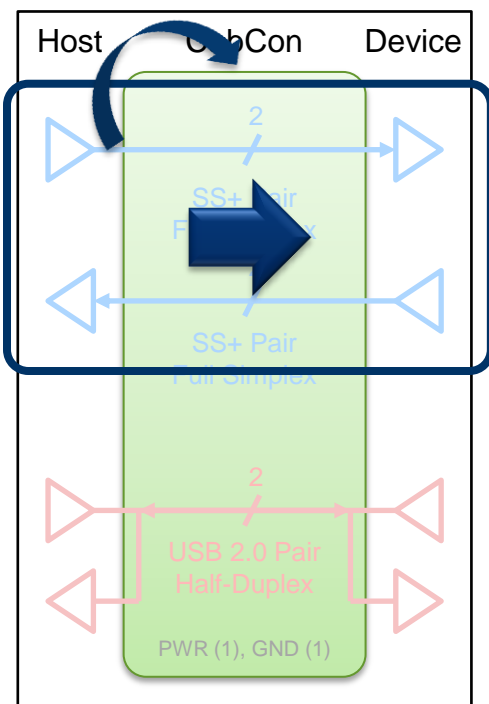
[Data Sheet] <http://literature.cdn.keysight.com/litweb/pdf/M9370-90002.pdf>

# USB 3.1 Cable/Connector Compliance Test

## Cable Shielding Effectiveness (Normative)

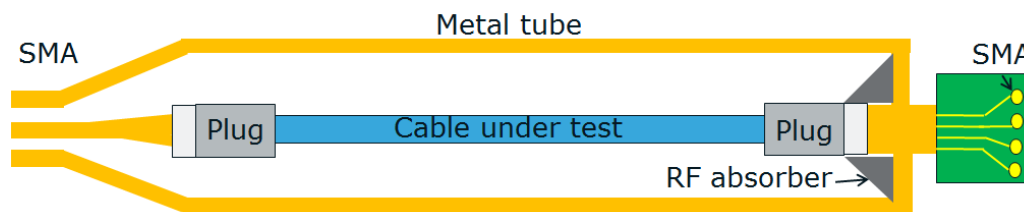


- Measures the radio frequency interference (RFI) level from the cable assembly.
- The coupling factor from differential Tx / Rx pairs to single-ended cable shield (i.e. Sds21/Scs21) is calculated.



Cable Shielding Effectiveness - Specification

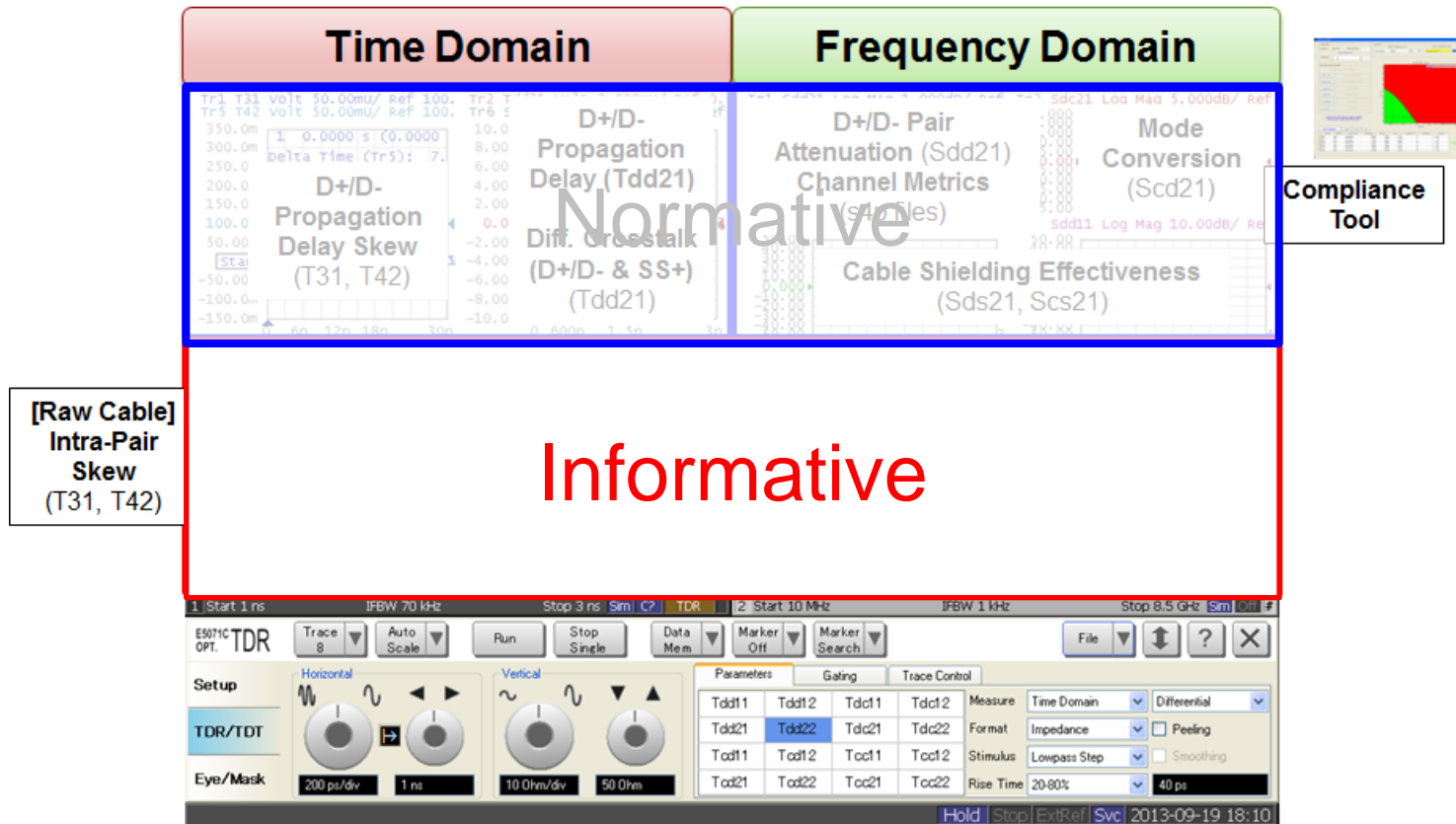
DUT Type	Limit
Cable assembly	$\leq -40$ dB (100 MHz to 10 GHz)



Setup for cable SE measurement (subject to change)

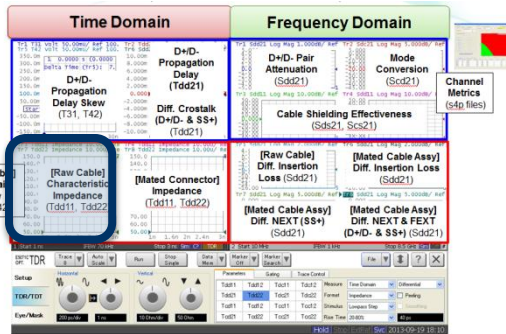
# USB 3.1 Cable/Connector Compliance Test

## Informative Parameters



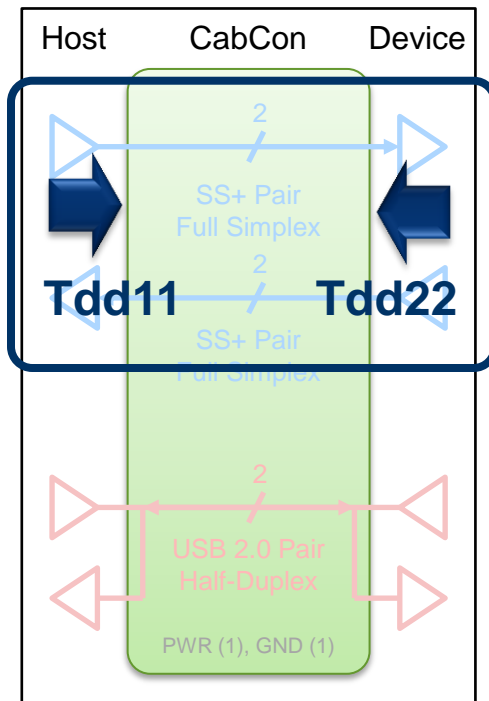
# USB 3.1 Cable/Connector Compliance Test

## [Raw Cable] Characteristic Impedance (Informative)



- Multiple reflections from impedance mismatches cause noise at the receiver. Therefore, the impedance profile provides an indication of multiple reflection induced noise.

- Impedance is the most used parameter, but is an indirect measure of the signal arriving at the receiver.



### [Raw Cable] Characteristic Impedance - Design Target

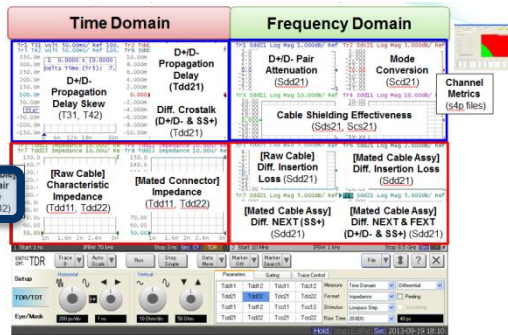
DUT Type	Limit
Shielded Differential Pair (SDP)	90 +- 5 ohm.
Single-ended coaxial SS+ signal wires	45 +- 3 ohm.

Note: Should be measured with a TDR in a differential mode using a 200 ps (10%-90%) rise time.

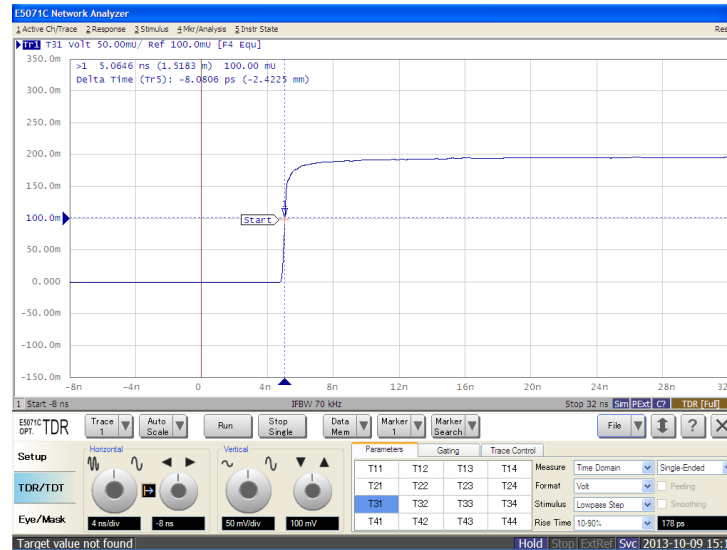
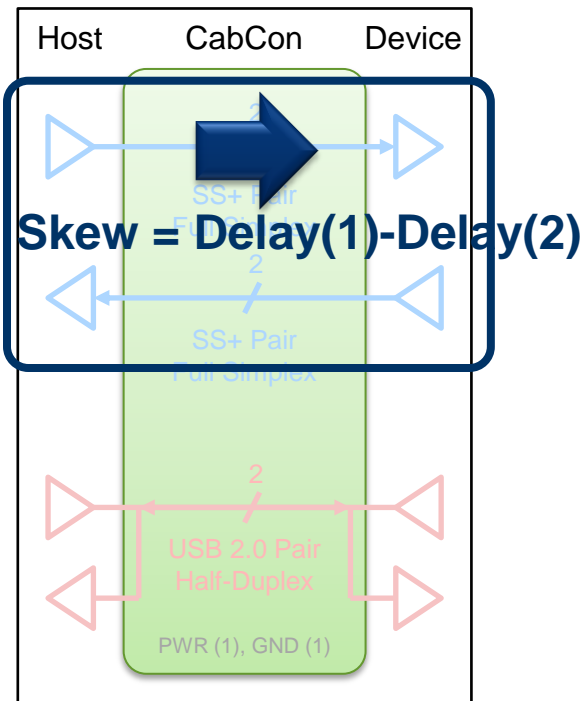


# USB 3.1 Cable/Connector Compliance Test

## [Raw Cable] Intra-Pair Skew (Informative)



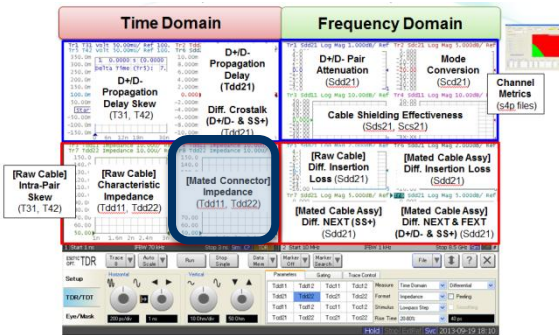
- Intra-pair skew measurement ensures the signal on both SS+ Tx+ and Tx- lines (or Rx+ and Rx- lines) of a cable assembly arrive at the receiver at the same time.
- If Delta Time < 15 ps/m: Pass, else: Fail



Note: Should be measured with a TDR in a differential mode using a 200 ps (10%-90%) rise time with a crossing at 50% of the input voltage.

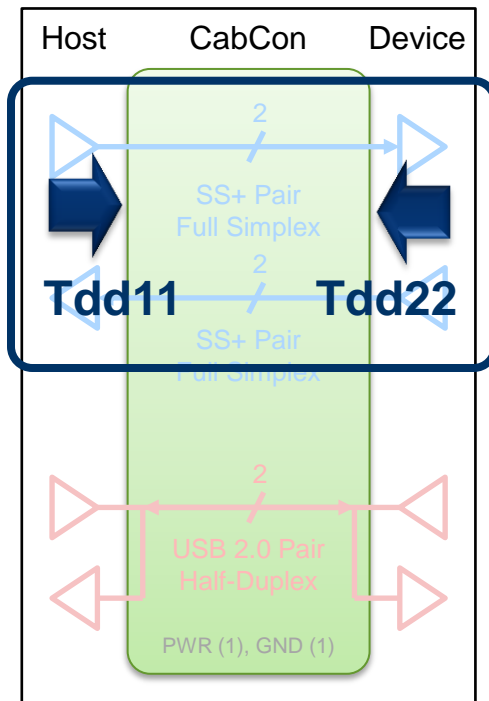
# USB 3.1 Cable/Connector Compliance Test

## [Mated Connector] Impedance (Informative)



- Multiple reflections from impedance mismatches cause noise at the receiver. Therefore, the impedance profile provides an indication of multiple reflection induced noise.

- Impedance is the most used parameter, but is an indirect measure of the signal arriving at the receiver.



### [Mated Connector] Impedance - Design Target

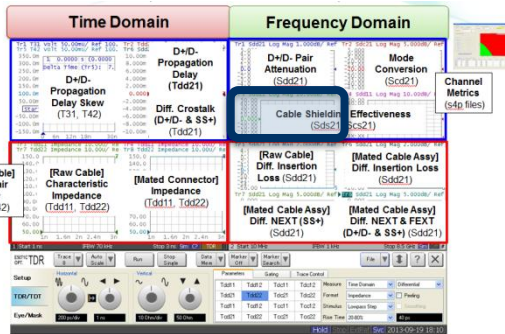
DUT Type	Limit
Mated connector	90 +- 10 ohm.

Note: Should be measured with a TDR in a differential mode using a 40 ps (20%-80%) rise time.  
 Note: The impedance profile is defined from the receptacle footprints through the plug cable termination area. In a case where the plug is directly attached to a device PCB, impedance profile includes the paths from the receptacle footprints to the plug footprints.

# USB 3.1 Cable/Connector Compliance Test

## [Raw Cable] Differential Insertion Loss (Informative)

- Measure of frequency response that the differential signal sees as it propagates through the interconnect.
- Cable loss depends on wire gauges, plating and dielectric materials.



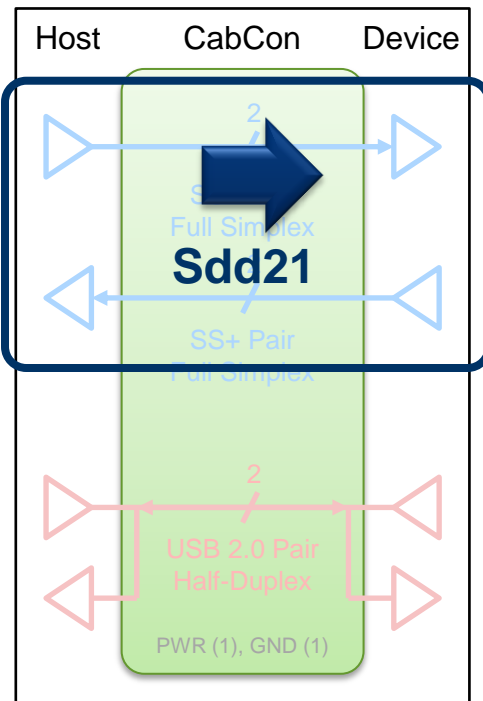
## [Raw Cable] Differential Insertion Loss - Design Target

### SDP Differential Insertion Loss Examples

Frequency	34AWG	32AWG	30AWG	28AWG
0.625 GHz	-1.8 dB/m	-1.4 dB/m	-1.2 dB/m	-1.0 dB/m
1.25 GHz	-2.5 dB/m	-2.0 dB/m	-1.7 dB/m	-1.4 dB/m
2.50 GHz	-3.7 dB/m	-2.9 dB/m	-2.5 dB/m	-2.1 dB/m
5.00 GHz	-5.5 dB/m	-4.5 dB/m	-3.9 dB/m	-3.1 dB/m
7.50 GHz	-7.0 dB/m	-5.9 dB/m	-5.0 dB/m	-4.1 dB/m

### SDP Differential Insertion Loss Example with Coaxial Construction

Frequency	34AWG	32AWG	30AWG	28AWG
0.625 GHz	-1.6 dB/m	-1.3 dB/m	-1.1 dB/m	-1.0 dB/m
1.25 GHz	-2.3 dB/m	-1.8 dB/m	-1.5 dB/m	-1.3 dB/m
2.50 GHz	-3.5 dB/m	-2.7 dB/m	-2.3 dB/m	-1.9 dB/m
5.00 GHz	-5.3 dB/m	-4.2 dB/m	-3.5 dB/m	-3.1 dB/m
7.50 GHz	-7.2 dB/m	-5.5 dB/m	-4.9 dB/m	-4.2 dB/m

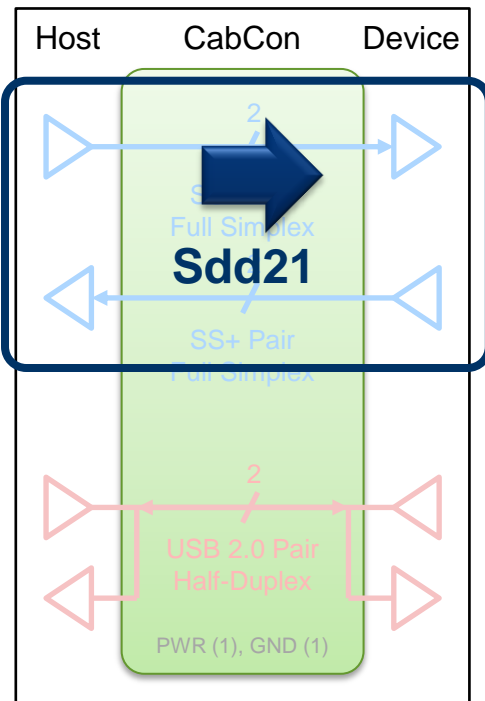
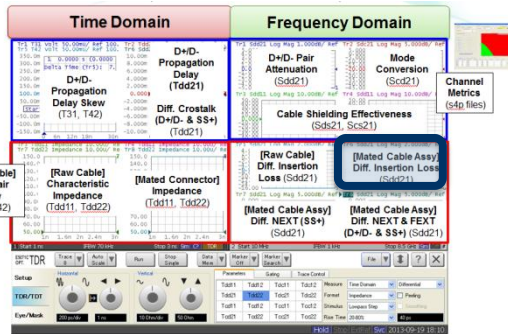
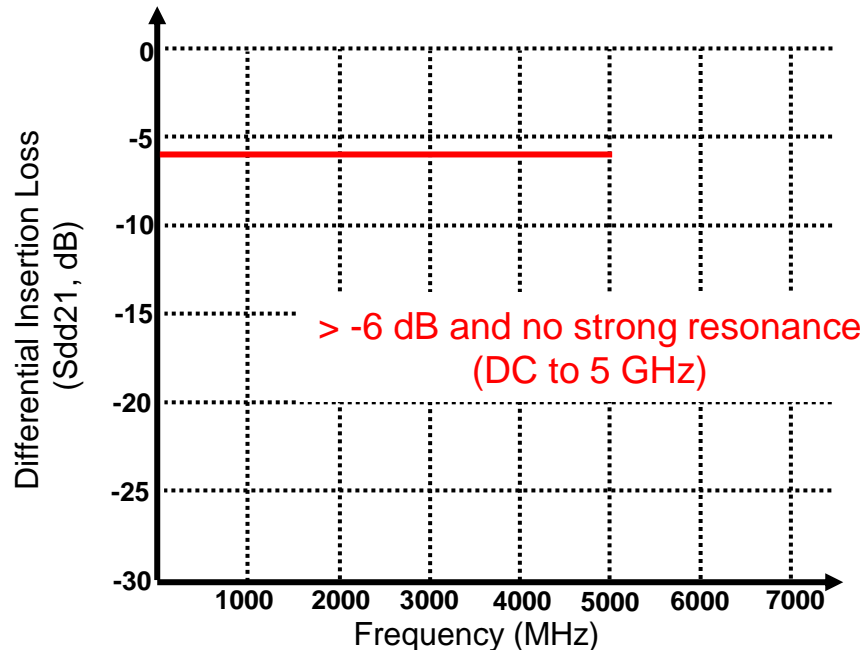


# USB 3.1 Cable/Connector Compliance Test

## [Mated Cable Assembly] Differential Insertion Loss (Informative)

- Measure of frequency response that the differential signal sees as it propagates through the interconnect.

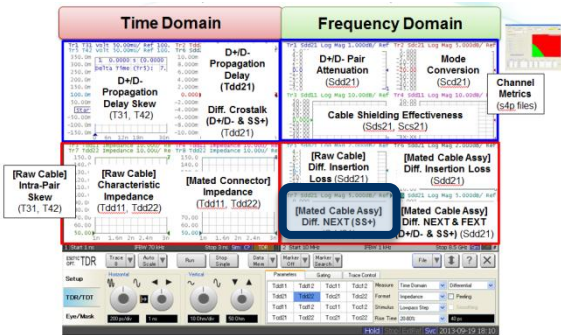
### [Mated Cable Assembly] Differential Insertion Loss - Design Target



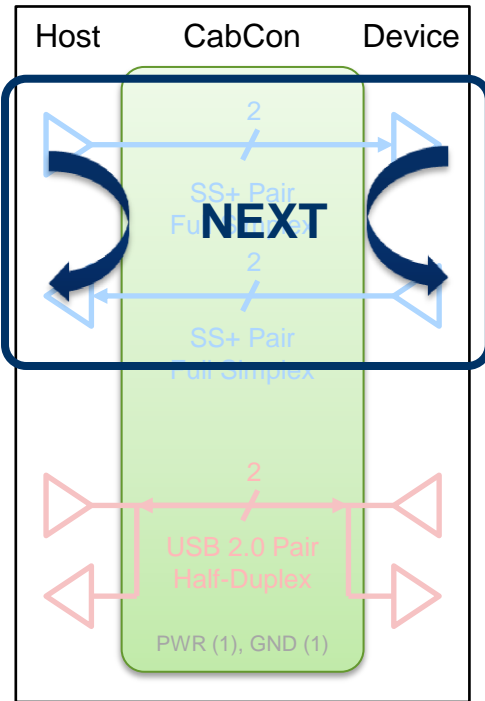
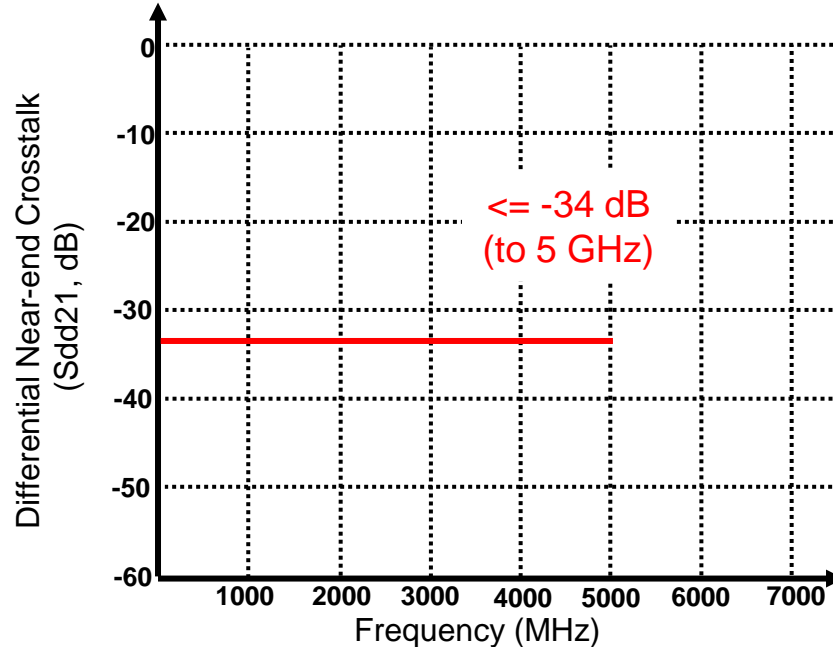
# USB 3.1 Cable/Connector Compliance Test

[Mated Cable Assembly] Differential NEXT between SS+ Signal Pairs (**Informative**)

• Measure of coupling between the SS+ differential pairs (Tx/Rx pair).



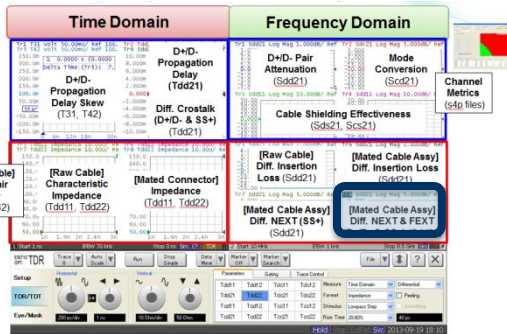
[Mated Cable Assembly] Differential NEXT - Design Target



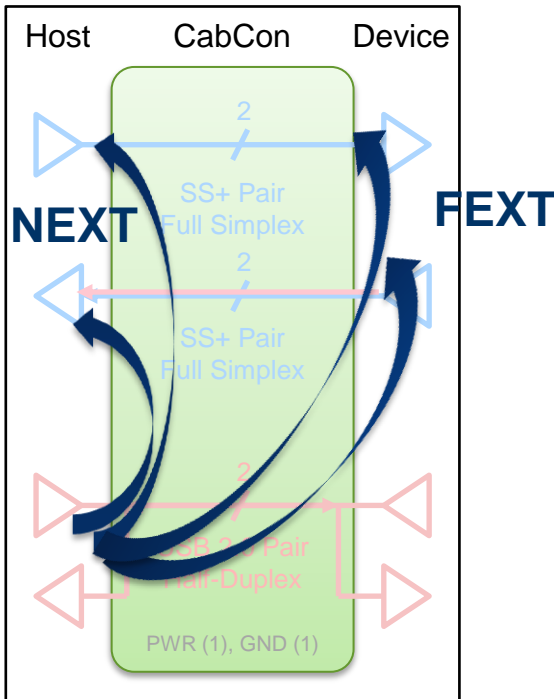
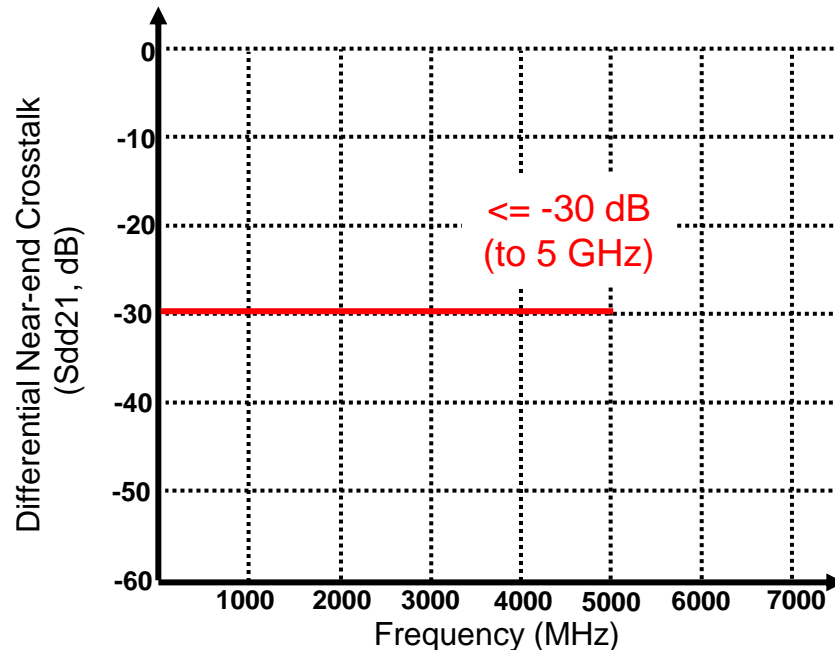
# USB 3.1 Cable/Connector Compliance Test

[Mated Cable Assembly] Differential NEXT & FEXT between D+/D- Pair and SS+ Signal Pairs (**Informative**)

- Measure of coupling between D+/D- pair and the SS+ differential pairs (Tx/Rx pair) **in frequency domain**.



[Mated Cable Assembly] Differential Crosstalk - Design Target

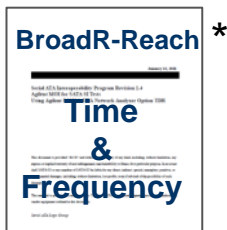
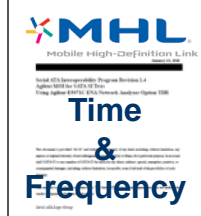
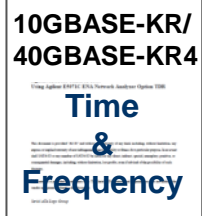
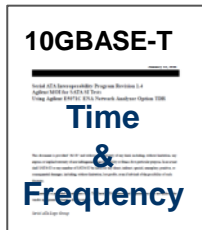
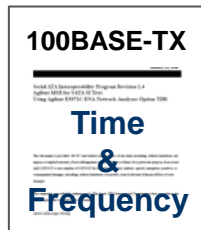
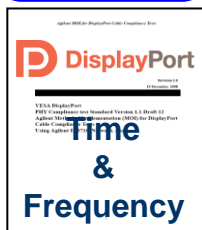
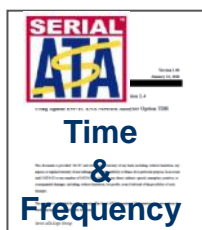
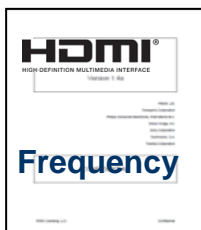




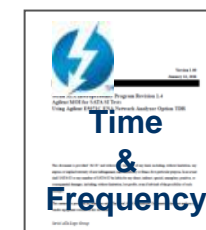
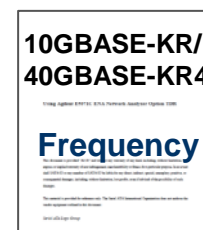
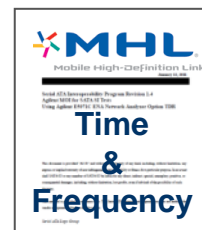
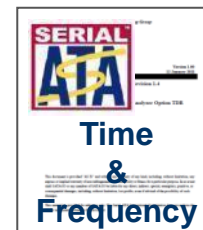
# ENA Option TDR Compliance Test Solution

Certified MOIs available at [www.keysight.com/find/ena-tdr\\_compliance](http://www.keysight.com/find/ena-tdr_compliance)

## Cable/Connector/Interconnect



## Transmitter/Receiver Impedance (Hot TDR/RL)



# USB 3.1 Cable/Connector Compliance Test Solution

## Summary



## ENA Option TDR Cable/Connector Compliance Testing Solution is ....

- **One-box solution** which provides complete characterization of high speed digital interconnects (time domain, frequency domain, eye diagram)
- Similar look-and-feel to traditional TDR scopes, providing **simple and intuitive operation** even for users unfamiliar to VNAs and S-parameters
- Adopted by test labs worldwide





# Questions?

# USB 3.0 => USB 3.1

## Measurement Parameters

### 1. Time Domain Measurements

USB 3.0 (5 Gbps)	USB 3.1 (10 Gbps)	Note
D+/D- Pair Propagation Delay	D+/D- Pair Propagation Delay	No change. USB 2.0.
D+/D- Pair Propagation Delay Skew	D+/D- Pair Propagation Delay Skew	No change. USB 2.0.
Differential Crosstalk between D+/D- Pair and SS Pairs	Differential Crosstalk between D+/D- and SS+ Signal Pairs	No change.
[Raw Cable] Characteristic Impedance (Informative)	[Raw Cable] Characteristic Impedance (Informative)	Specification is changed: 83 to 97 ohm => 85 to 95 ohm.
SS Lines Intra-Pair Skew (Informative)	[Raw Cable] Intra-Pair Skew (Informative)	No change.
[Mated Connector] Impedance	[Mated Connector] Impedance (Informative)	Changed from Normative to Informative. Specification is changed: 75 to 105 ohm @ 50 ps (20-80%) => 80 to 100 ohm @ 40 ps (20-80%)

Note: normative parameters in blue, informative parameters in red.

# USB 3.0 => USB 3.1

## Measurement Parameters

### 2. Frequency Domain Measurements

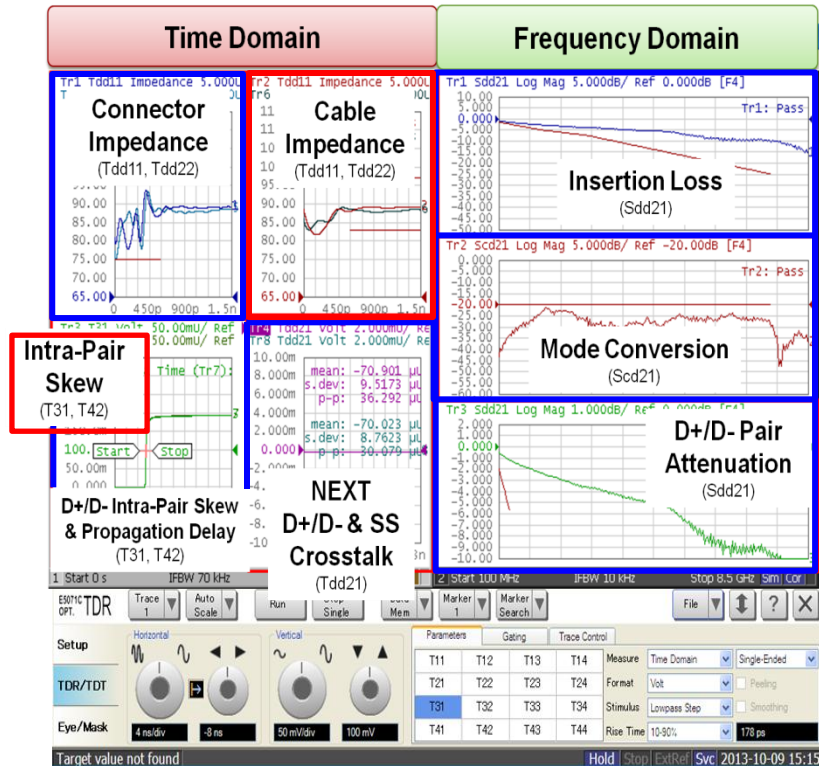
USB 3.0 (5 Gbps)	USB 3.1 (10 Gbps)	Note
D+/D- Pair Attenuation	D+/D- Pair Attenuation	No change. USB 2.0.
Differential to Common Mode Conversion	Differential to Common Mode Conversion	Frequency range is extended up to 10 GHz. (100 M to 7.5 GHz => 100 M to 10 GHz)
-	Channel Metrics (ILfitatNq, IMR, IXT, eW, eH)	Newly added for USB 3.1. Compliance test tool provided by USB-IF is necessary.
-	Cable Shielding Effectiveness	Newly added for USB 3.1.
[Raw Cable] Differential Insertion Loss (Informative)	[Raw Cable] Differential Insertion Loss (Informative)	Specification is changed. Better loss needed.
Differential Insertion Loss	[Mated Cable Assembly] Differential Insertion Loss (Informative)	Changed from Normative to Informative. Specification is changed: (=> >-6 dB (DC to 5 GHz)
Differential Near End Crosstalk Between SS Pairs (Time domain)	[Mated Cable Assembly] Differential NEXT between SS+ Signal Pairs (Informative)	NEXT is measured in frequency domain for USB 3.1. Changed from Normative to Informative.
-	[Mated Cable Assembly] Differential NEXT and FEXT between D+/D- pair and SS+ Signal Pairs (Informative)	Crosstalk are measured in time domain as well (Normative).

Note: normative parameters in blue, informative parameters in red.

# USB 3.0 => USB 3.1

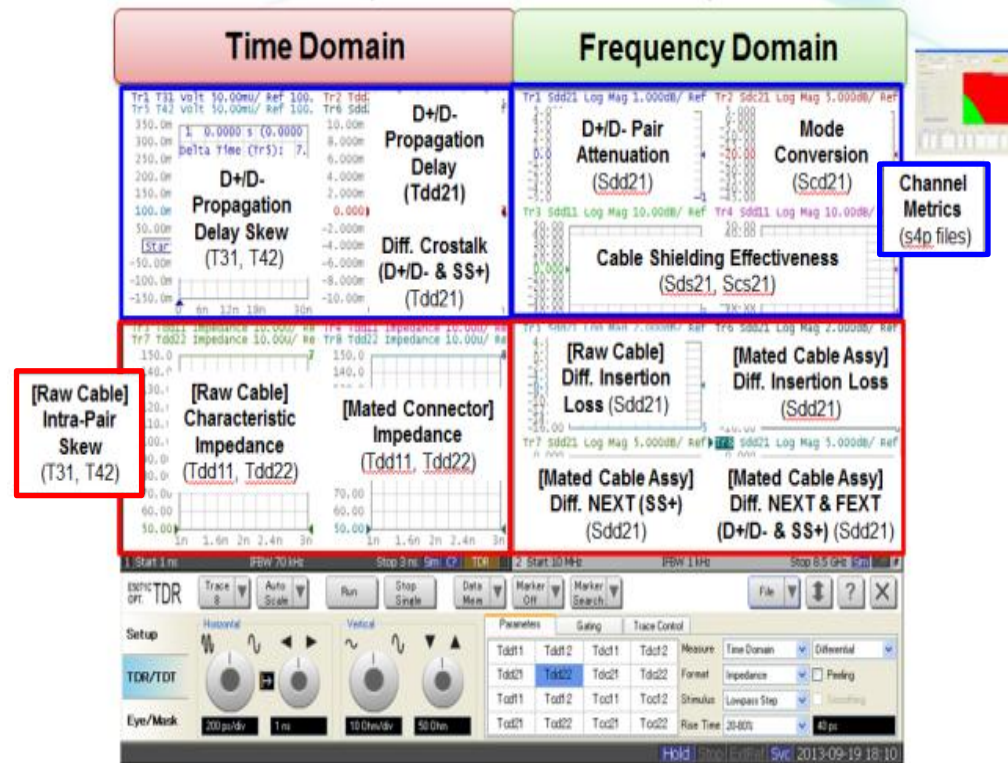
## Measurement Parameters

### USB 3.0



Note: Normative parameters in blue,  
informative parameters in red.

### USB 3.1



Note: Normative parameters in blue,  
informative parameters in red.

# Keysight VNA Solutions

Performance



## FieldFox

Handheld RF Analyzer  
5 Hz to 4/6 GHz



### E5061B

NA + ZA in one-box

5 Hz to 3 GHz  
Low cost RF VNA  
100 k to 1.5/3.0 GHz



### E5071C

World's most popular economy VNA  
9 kHz to 4.5, 8.5 GHz  
300 kHz to 20.0 GHz



### E5072A

Best performance ENA  
30 kHz to 4.5, 8.5 GHz

## ENA Series



### PNA

Performance VNA  
10 M to 20, 40, 50, 67, 110 GHz  
Banded mm-wave to 2 THz



### PNA-L

World's most capable value VNA  
300 kHz to 6, 13.5, 20 GHz  
10 MHz to 40, 50 GHz



### PNA-X receiver

8530A replacement



### PNA-X, NVNA

Industry-leading performance  
10 M to 13.5/26.5/43.5/50/67 GHz  
Banded mm-wave to 2 THz



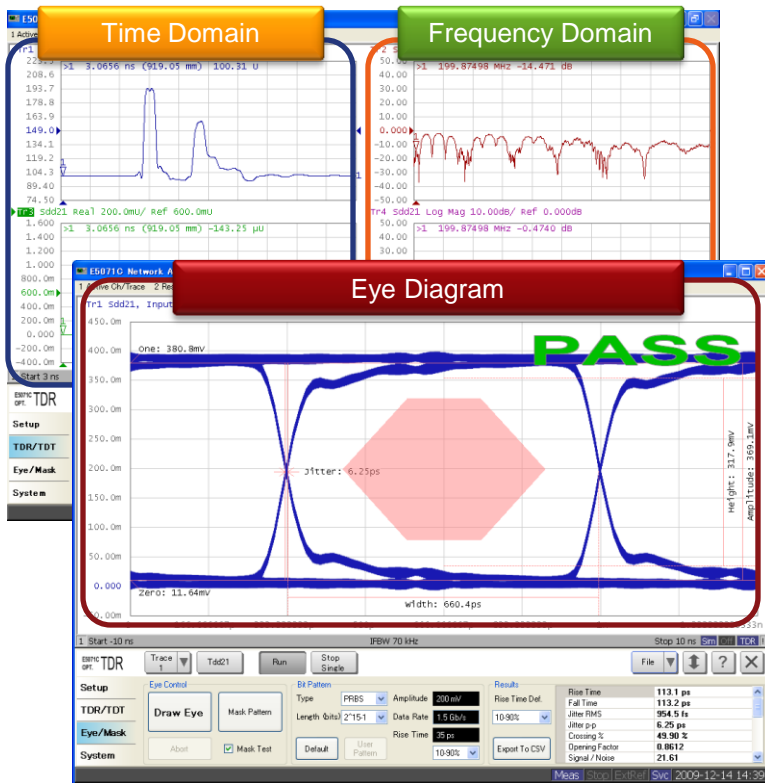
### Mm-wave solutions

Up to 2 THz

## PNA Series

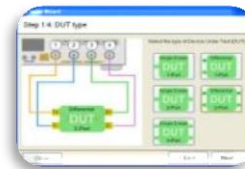
# What is ENA Option TDR?

The ENA Option TDR is an application software embedded on the ENA, which provides an **one-box solution** for high speed serial interconnect analysis.



## 3 Breakthroughs

for Signal Integrity Design and Verification



Simple and Intuitive Operation



Fast and Accurate Measurements



ESD Robustness

# What is ENA Option TDR?

[Video]

## Keysight ENA Option TDR

*Changing the world of Time Domain Reflectometry (TDR) Measurements*

- [www.youtube.com/watch?v=hwQNllyJ5hI&list=UUAJAjd97CfnCehC4jZAfkxQ&index=20&feature=plcp](http://www.youtube.com/watch?v=hwQNllyJ5hI&list=UUAJAjd97CfnCehC4jZAfkxQ&index=20&feature=plcp)
- [www.keysight.com/find/ena-tdr](http://www.keysight.com/find/ena-tdr)





# Additional Resources

## •ENA Option TDR Reference Material

[www.keysight.com/find/ena-tdr](http://www.keysight.com/find/ena-tdr)

### •Technical Overview (5990-5237EN)

### •Application Notes

- Correlation between TDR oscilloscope and VNA generated time domain waveform (5990-5238EN)
- Comparison of Measurement Performance between Vector Network Analyzer and TDR Oscilloscope (5990-5446EN)
- Effective Hot TDR Measurements of Active Devices Using ENA Option TDR (5990-9676EN)
- Measurement Uncertainty of VNA Based TDR/TDT Measurement (5990-8406EN)
- Accuracy Verification of Keysight's ENA Option TDR Time Domain Measurement using a NIST Traceable Standard (5990-5728EN)

## •Method of Implementation (MOI) for High Speed Digital Standards

[www.keysight.com/find/ena-tdr\\_compliance](http://www.keysight.com/find/ena-tdr_compliance)

